Freescale Semiconductor,

Freescale Semiconductor, Inc.

MC68HC05SU3A

TECHNICAL DATA



For More Information On Go to: www.freescale.com



| | Freescale Semiconductor, Inc. |
|----|-------------------------------------|
| 1 | GENERAL DESCRIPTION |
| 2 | PIN DESCRIPTIONS |
| 3 | INPUT/OUTPUT PORTS |
| 4 | MEMORY AND REGISTERS |
| 5 | RESETS AND INTERRUPTS |
| 6 | TIMER |
| 7 | CPU CORE AND INSTRUCTION SET |
| 8 | LOW POWER MODES |
| 9 | OPERATING MODES |
| 10 | ELECTRICAL SPECIFICATIONS |
| 11 | MECHANICAL SPECIFICATIONS |

Freescale Semiconductor, Inc. GENERAL DESCRIPTION

PIN DESCRIPTIONS

INPUT/OUTPUT PORTS

MEMORY AND REGISTERS

RESETS AND INTERRUPTS

TIMER

1

CPU CORE AND INSTRUCTION SET

LOW POWER MODES

OPERATING MODES

ELECTRICAL SPECIFICATIONS

MECHANICAL SPECIFICATIONS

MC68HC05SU3A

High-density Complementary Metal Oxide Semiconductor (HCMOS) Microcontroller Unit

Conventions

Register and bit mnemonics are defined in the paragraphs describing them.

An overbar is used to designate an active-low signal, eg: RESET.

Unless otherwise stated, blank cells in a register diagram indicate that the bit is either unused or reserved; shaded cells indicate that the bit is not described in the following paragraphs; 'u' is used to indicate an undefined state (on reset).

TABLE OF CONTENTS

Paragraph Number

TITLE

Page Number

1 GENERAL DESCRIPTION

| 1.1 | Features | .1- | 1 |
|-----|---------------|-----|---|
| 1.2 | Mask Options | .1- | 2 |
| 1.3 | MCU Structure | .1- | 2 |

2 PIN DESCRIPTIONS

| 2.1 | Functional Pin Descriptions | 2-1 |
|-------|-----------------------------|-----|
| 2.2 | OSC1 and OSC2 Connections | 2-2 |
| | Crystal Oscillator | |
| | External Clock | |
| 2.2.3 | RC Oscillator Option | 2-4 |
| 2.3 | Pin Assignments | 2-5 |

3 INPUT/OUTPUT PORTS

| Parallel Ports | 3-1 |
|------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Port Data Registers | 3-1 |
| Port Data Direction Registers | 3-2 |
| Port A — Keyboard Interrupts (KBI) | 3-2 |
| PD6 — IRQ2 | 3-2 |
| Programmable Current Drive | 3-3 |
| Programmable Pull-Up Devices | 3-3 |
| Port Option Register | 3-3 |
| | Port Data Registers Port Data Direction Registers Port A — Keyboard Interrupts (KBI) PD6 — IRQ2 Programmable Current Drive Programmable Pull-Up Devices |

4 MEMORY AND REGISTERS

| I/O Registers | 4- | 1 |
|---------------|---------------|-----------------|
| | I/O Registers | I/O Registers4- |

Paragraph Number

TITLE

Page Number

| 4.2 | RAM | 4-1 |
|-----|-----------------------|-----|
| | ROM | |
| 4.4 | Memory Map | 4-2 |
| 4.5 | I/O Registers Summary | 4-3 |

5 RESETS AND INTERRUPTS

| 5.1 | RESETS | 5-1 |
|---------|---------------------------------------|-----|
| 5.1.1 | Power-On Reset (POR) | 5-1 |
| 5.1.2 | RESET Pin | 5-1 |
| 5.1.3 | Low Voltage Reset (LVR) | 5-2 |
| 5.2 | INTERRUPTS | 5-2 |
| 5.2.1 | Non-maskable Software Interrupt (SWI) | 5-3 |
| 5.2.2 | Maskable Hardware Interrupts | 5-5 |
| 5.2.2.2 | External Interrupt (IRQ) | 5-5 |
| 5.2.2.2 | 2 External Interrupt 2 (IRQ2) | 5-7 |
| 5.2.2.3 | 3 Timer Interrupt | 5-7 |
| 5.2.2.4 | 4 Keyboard Interrupt (KBI) | 5-8 |

6

TIMER

| 6.1 | Timer Overview | 6-1 |
|-----|----------------------------------|-----|
| | Timer Control Register (TCR) | |
| 6.3 | Timer Data Register (TDR) | 6-4 |
| 6.4 | Operation during Low Power Modes | 6-4 |

7

CPU CORE AND INSTRUCTION SET

| 7.1 | Registers | 7-1 |
|-------|--------------------------------|-----|
| 7.1.1 | Accumulator (A) | 7-1 |
| 7.1.2 | Index register (X) | 7-2 |
| 7.1.3 | Program counter (PC) | 7-2 |
| 7.1.4 | Stack pointer (SP) | |
| 7.1.5 | Condition code register (CCR) | 7-2 |
| 7.2 | Instruction set | 7-3 |
| 7.2.1 | Register/memory Instructions | 7-4 |
| 7.2.2 | Branch instructions | 7-4 |
| 7.2.3 | Bit manipulation instructions | 7-4 |
| 7.2.4 | Read/modify/write instructions | 7-4 |
| 7.2.5 | Control instructions | 7-4 |
| | | |

Paragraph Number

TITLE

Page Number

| 7.2.6 | Tables | |
|--------|------------------------|------|
| 7.3 | Addressing modes | 7-11 |
| 7.3.1 | Inherent | 7-11 |
| 7.3.2 | Immediate | 7-11 |
| 7.3.3 | Direct | 7-11 |
| 7.3.4 | Extended | |
| 7.3.5 | Indexed, no offset | |
| 7.3.6 | Indexed, 8-bit offset | |
| 7.3.7 | Indexed, 16-bit offset | |
| 7.3.8 | Relative | |
| 7.3.9 | Bit set/clear | |
| 7.3.10 | Bit test and branch | 7-13 |

8 LOW POWER MODES

| 8.1 | STOP Mode | 8-1 |
|-----|-----------|-----|
| 8.2 | WAIT Mode | 8-1 |
| 8.3 | SLOW Mode | 8-3 |

9 OPERATING MODES

| 9.1 | User Mode | .9-1 |
|-----|-----------------|------|
| 9.2 | Self-Check Mode | .9-1 |

10

ELECTRICAL SPECIFICATIONS

| 10.1 | Maximum Ratings | 10-1 |
|------|-------------------------------|------|
| | Thermal Characteristics | |
| 10.3 | DC Electrical Characteristics | 10-2 |
| 10.4 | Control Timing | 10-3 |

11 MECHANICAL SPECIFICATIONS

| 11.1 | 40-Pin DIP Package (Case 711-03) | 11-2 |
|------|-----------------------------------|------|
| | 42-Pin SDIP Package (Case 858-01) | |
| | 44-pin QFP Package (Case 824A-01) | |

MC68HC05SU3A

THIS PAGE LEFT BLANK INTENTIONALLY

LIST OF FIGURES

| Figure Number | TITLE | Page Number |
|------------------|-------------------------------------------------------------|----------------|
| 1-1 | | 1.0 |
| • • | MC68HC05SU3A Block Diagram | |
| 2-1 | Oscillator Connections | |
| 2-2 | Typical Oscillator Frequency for Selected External Resistor | |
| 2-3 | Typical Oscillator Frequency for Wire-Strap Connection | |
| 2-4 | Pin Assignment for 40-pin PDIP | 2-5 |
| 2-5 | Pin Assignment for 42-pin SDIP | 2-6 |
| 2-6 | Pin Assignment for 44-pin QFP | 2-6 |
| 3-1 | Port I/O Circuitry | 3-2 |
| 4-1 | MC68HC05SU3A Memory Map | 4-2 |
| 5-1 | Interrupt Stacking Order | 5-3 |
| 5-2 | Hardware Interrupt Processing Flowchart | 5-4 |
| 5-3 | External Interrupt | 5-6 |
| 5-4 | Keyboard Interrupt Circuitry | 5-8 |
| 6-1 | Timer Block Diagram | 6-2 |
| 7-1 | Programming model | 7-1 |
| 7-2 | Stacking order | 7-2 |
| 8-1 | STOP and WAIT Mode Flowcharts | 8-2 |
| 9-1 | MC68HC05SU3A Self-Check Circuit | 9-2 |
| 11-1 | 40-pin DIP Package | 11-2 |
| 11-2 | 42-pin SDIP Package | 11-2 |
| 1-3 | 44-pin QFP Package | 11-3 |

THIS PAGE LEFT BLANK INTENTIONALLY

LIST OF TABLES

TITLE

| 1-1 | Power-On Reset Delay Mask Option | 1-2 |
|------|----------------------------------|------|
| 3-1 | I/O Pin Functions | 3-1 |
| 4-1 | MC68HC05SU3A I/O Registers | 4-3 |
| 5-1 | Reset/Interrupt Vector Addresses | 5-3 |
| 7-1 | MUL instruction | 7-5 |
| 7-2 | Register/memory instructions | 7-5 |
| 7-3 | Branch instructions | 7-6 |
| 7-4 | Bit manipulation instructions | 7-6 |
| 7-5 | Read/modify/write instructions | 7-7 |
| 7-6 | Control instructions | 7-7 |
| 7-7 | Instruction set | |
| 7-8 | M68HC05 opcode map | |
| 9-1 | Mode Selection | 9-1 |
| 9-2 | Self-Check Report | |
| 10-1 | DC Electrical Characteristics | |
| 10-2 | Control Timing | 10-3 |

For More Information On This Product, Go to: www.freescale.com

Freescale Semiconductor, Inc.

Table

Number

Page

Number

THIS PAGE LEFT BLANK INTENTIONALLY

1 GENERAL DESCRIPTION

The MC68HC05SU3A HCMOS microcontroller is a member of the M68HC05 family of low-cost single-chip microcontrollers. This 8-bit microcontroller unit (MCU) contains on-chip oscillator, CPU, RAM, ROM, I/O, and Timer. The MC68HC05SU3A is pin compatible with the MC6805U3 and is provided as a low power upgrade path for MC6805U3 applications. The low power advantage of CMOS is combined with the addition of I/O and port modifications which help eliminate external components in cost sensitive applications.

1.1 Features

- Fully static chip design featuring the industry standard 8-bit M68HC05 core
- Pin compatible with the MC6805U3
- Power saving STOP, WAIT, and SLOW modes
- 3840 bytes of user ROM with security feature
- 192 bytes of user RAM (64 bytes for stack)
- 32 bidirectional I/O lines
- Keyboard interrupts
- 8-bit count-down timer with programmable 7-bit prescaler
- On-chip crystal oscillator, with built-in capacitor for RC option
- Second software programmable external interrupt line (IRQ2)
- Direct LED drive capability on all ports
- Programmable 20KΩ pull-up resistors integrated into I/O ports (1.9KΩ pull-up resistors integrated into PB0 and PB1)
- Internal 60K Ω pull-up resistor on RESET pin
- Internal 100K Ω pull-up resistor on \overline{IRQ} pin
- Low Voltage Reset
- Available in 40-pin PDIP, 42-pin SDIP and 44-pin QFP packages

MC68HC05SU3A

GENERAL DESCRIPTION For More Information On This Product, Go to: www.freescale.com

Mask Options 1.2

The following mask options are available:

- RC or Crystal Oscillator (see Section 2.2). The default is crystal option. ٠
- IRQ pull-up resistor enabled or disabled. ٠
- Power-On Reset delay Table 1-1 shows available options. The default value is 4096 cycles.

| Power-On Reset Delay (cycles) | |
|----------------------------------|--|
| 256 | |
| 512 | |
| 1024 | |
| 2048 | |
| 4096 | |
| 8192 | |
| 16384 | |
| 32768 | |

Table 1-1 Power-On Reset Delay Mask Option

 Power-On Reset Slow mode. If enabled, the device goes into Slow mode directly upon power-on reset. The bus frequency is 16 times slower than the normal mode. Thus, the power-on reset delay will also be 16 times longer. The default setting is "Slow mode" disabled.

1.3 **MCU Structure**

Figure 1-1 shows a block diagram of the MC68HC05SU3A MCU.

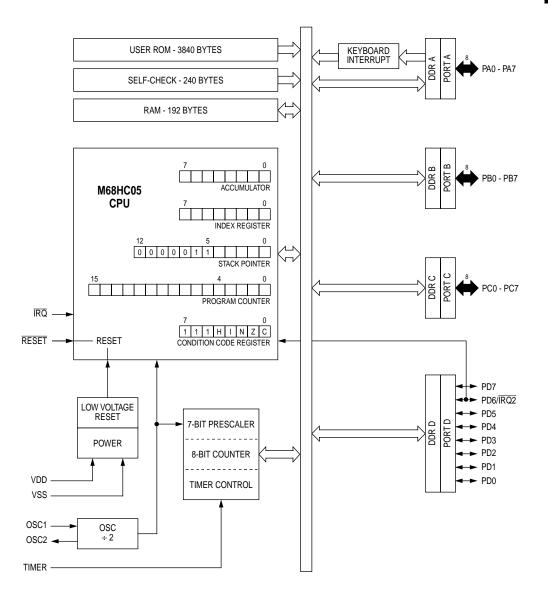


Figure 1-1 MC68HC05SU3A Block Diagram

GENERAL DESCRIPTION For More Information On This Product, Go to: www.freescale.com

THIS PAGE LEFT BLANK INTENTIONALLY

2 PIN DESCRIPTIONS

This section provides a description of the functional pins of the MC68HC05SU3A microcontroller.

2.1 Functional Pin Descriptions

| PIN NAME | 40-pin PDIP PIN No. | 42-pin SDIP PIN No. | 44-pin QFP PIN No. | DESCRIPTION |
|------------|------------------------|------------------------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VDD | 4 | 5 | 10, 33 | Power is supplied to the MCU using these pins. |
| VSS | 1 | — | 32 | VDD should be connected to the positive supply. |
| VSS(INT) | _ | 1 | 6 | VSS, VSS(INT), and VSS(EXT) should be connected to |
| VSS(EXT) | - | 2 | 7 | supply ground. |
| VPP | 7 | 8 | 13 | This is not used, it should be connected to VDD or VSS. |
| IRQ | 3 | 4 | 9 | IRQ is software programmable to provide two choices of interrupt triggering sensitivity. These options are: negative-edge-sensitive triggering only, or both negative-edge-sensitive and level-sensitive triggering. This pin has an integrated pull-up resistor to VDD but should be tied to VDD if not needed to improve noise immunity. The IRQ pin contains an internal Schmitt trigger as part of its input to improve noise immunity. The voltage on this pin may affect the mode of operation as described in Section 9. |
| RESET | 2 | 3 | 8 | This pin can be used as an input to reset the MCU to a known start-up state by pulling it to the low state. The RESET pin contains an internal Schmitt trigger to improve its noise immunity as an input. It also has an internal pull-down device that pulls the RESET pin low during the power-on reset cycles and an integrated pull-up resistor to VDD. |
| TIMER | 8 | 9 | 14 | The TIMER pin provides an optional gating input to the timer. Refer to Section 6 for additional information. |
| OSC1, OSC2 | 5, 6 | 6, 7 | 11, 12 | The OSC1 and OSC2 pins are the connections for the on-chip oscillator. See Section 2.2 for detail. |

PIN DESCRIPTIONS For More Information On This Product, Go to: www.freescale.com

DESCRIPTION

44-pin QFP

PIN No.

2

| PAO-PA7 | 33-40 | 34-41 | 42-44, 1-5 | These eight I/O lines comprise port A. The state of any pin is software programmable. All port A lines are configured as input during power-on or external reset. PA0-PA7 are also associated with the Keyboard Interrupt function. Each pin is equipped with a programmable integrated 20K Ω pull-up resistor connected to VDD when configured as input. When programmed as output, each pin can provide a current drive of 10mA. See Section 3 for details on the I/O ports. |
|---------|--------------|--------------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PB0-PB7 | 25-32 | 26-33 | 31, 35-41 | These eight I/O lines comprise port B. The state of any pin is software programmable. All port B lines are configured as input during power-on or external reset. PB0 and PB1 are equipped with an integrated 1.9K Ω pull-up resistor. PB2-PB7 are equipped with a programmable integrated 20K Ω pull-up resistor connected to VDD when configured as input. When programmed as output, each pin can provide a current drive of 10mA. PB5-PB7 can also be programmed to provide a lower current drive of 2mA. See Section 3 for details on the I/O ports. |
| PC0-PC7 | 9-16 | 10-17 | 15-22 | These eight I/O lines comprise port C. The state of any pin is software programmable. All port C lines are configured as input during power-on or external reset. Each pin is equipped with a programmable integrated $20K\Omega$ pull-up resistor connected to VDD when configured as input. When programmed as output, each pin can provide a current drive of 10mA. See Section 3 for details on the I/O ports. |
| PD0-PD7 | 24-21, 20-17 | 25-22, 21-18 | 30-23 | These eight I/O lines comprise port D. The state of any pin is software programmable. All port D lines are configured as input during power-on or external reset. Each pin is equipped with a programmable integrated $20K\Omega$ pull-up resistor connected to VDD when configured as input. When programmed as output, each pin can provide a current drive of 10mA. |
| IRQ2 | 18 | 19 | 24 | PD6 is configured as IRQ2 by setting IRQ2E in the Miscellaneous Control Register (\$0C). See Section 3 for details on the I/O ports. |

2.2 OSC1 and OSC2 Connections

40-pin PDIP

PIN No.

PIN NAME

42-pin SDIP

PIN No.

The OSC1 and OSC2 pins are the connections for the on-chip oscillator — the following configurations are available:

- 1) A crystal or ceramic resonator as shown in Figure 2-1(a).
- 2) An external clock signal as shown in Figure 2-1(b).
- 3) RC options as shown in Figure 2-1(c) and Figure 2-1(d).

The external oscillator clock frequency, f_{OSC} , is divided by two to produce the internal operating frequency, f_{OP} .

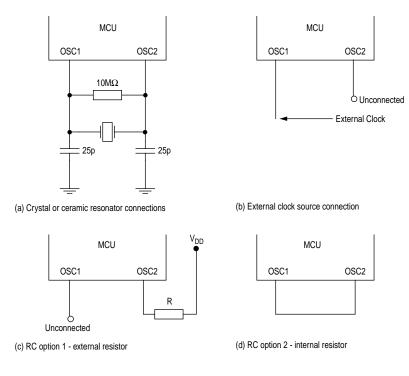


Figure 2-1 Oscillator Connections

2.2.1 Crystal Oscillator

The circuit in Figure 2-1(a) shows a typical oscillator circuit for an AT-cut, parallel resonant crystal. The crystal manufacturer's recommendations should be followed, as the crystal parameters determine the external component values required to provide maximum stability and reliable start-up. The load capacitance values used in the oscillator circuit design should include all stray capacitances. The crystal and components should be mounted as close as possible to the pins for start-up stabilization and to minimize output distortion. An external start-up resistor of approximately $10M\Omega$ is needed between OSC1 and OSC2 for the crystal type oscillator.

2.2.2 External Clock

An external clock from another CMOS-compatible device can be connected to the OSC1 input, with the OSC2 input not connected, as shown in Figure 2-1(b).

PIN DESCRIPTIONS For More Information On This Product, Go to: www.freescale.com

2.2.3 RC Oscillator Option

This configuration is intended to be the lowest cost option in applications where oscillator accuracy is not important. An internal constant current source and a capacitor have been integrated on-chip, connected between the OSC2 pin and VSS. Thus by either connecting a resistor to VDD from OSC2 or by putting a wire strap between OSC1 and OSC2 self-oscillations at the frequency as shown in Figure 2-2 and Figure 2-3 can be induced.

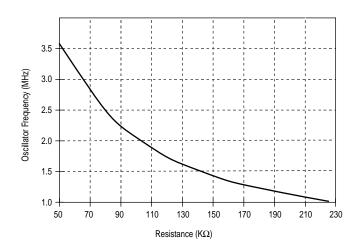


Figure 2-2 Typical Oscillator Frequency for Selected External Resistor

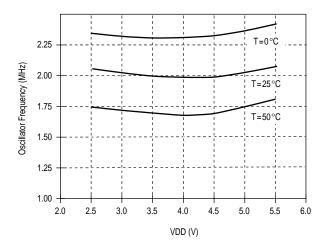


Figure 2-3 Typical Oscillator Frequency for Wire-Strap Connection

2

2.3 Pin Assignments

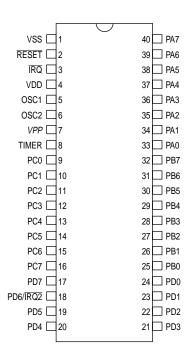


Figure 2-4 Pin Assignment for 40-pin PDIP

DC

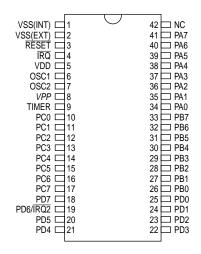


Figure 2-5 Pin Assignment for 42-pin SDIP

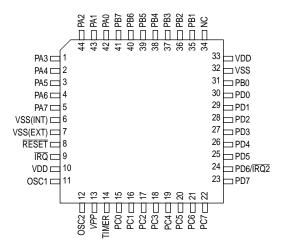


Figure 2-6 Pin Assignment for 44-pin QFP

3 INPUT/OUTPUT PORTS

The MC68HC05SU3A has 32 bidirectional I/O lines, arranged as four 8-bit I/O ports (Port A, B, C, and D). The individual bits in these ports are programmable as either inputs or outputs under software control by the Data Direction Registers (DDRs). All port pins (except PB0 and PB1) each has an associated 20K Ω pull-up resistor, which can be connected/disconnected under software control. Also, each port pin (except PB0 and PB1) is capable of sinking and driving a maximum current of 10mA (e.g. direct drive for LEDs). PB0 and PB1 each has a permanent 1.9K Ω pull-up resistor connected, with 20mA current sink capability. Port A can also be configured for keyboard interrupts.

3.1 Parallel Ports

Port A, B, C, and D are 8-bit bidirectional ports. Each Port pin is controlled by the corresponding bits in a Data Direction Register and a Data Register as shown in Figure 3-1. The functions of the I/O pins are summarized in Table 3-1.

| R/W | DDR | I/O Pin Function | | | | | | | |
|-----|-----|---------------------------------------------------------------------------|--|--|--|--|--|--|--|
| 0 | 0 | The I/O pin is in input mode. Data is written into the output data latch. | | | | | | | |
| 0 | 1 | Data is written into the output data latch and output to the I/O pin. | | | | | | | |
| 1 | 0 | The state of the I/O pin is read. | | | | | | | |
| 1 | 1 | The I/O pin is in an output mode. The output data latch is read. | | | | | | | |

| Table 3-1 | I/O Pin Functions |
|-----------|-------------------|
| | |

3.1.1 Port Data Registers

Each Port I/O pin has a corresponding bit in the Port Data Register. When a Port I/O pin is programmed as an output the state of the corresponding data register bit determines the state of the output pin. All Port I/O pins can drive a current of 10mA when programmed as outputs. When a Port pin is programmed as an input, any read of the Port Data Register will return the logic state of the corresponding I/O pin. The locations of the Data Registers for Port A, B, C, and D are at \$00, \$01, \$02, and \$03 respectively. The Port Data Registers are unaffected by reset.

INPUT/OUTPUT PORTS For More Information On This Product, Go to: www.freescale.com

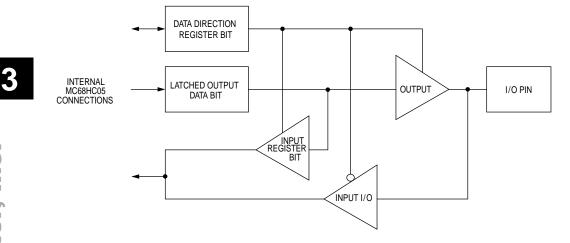


Figure 3-1 Port I/O Circuitry

3.1.2 Port Data Direction Registers

Each port pin may be programmed as an input by clearing the corresponding bit in the DDR, or programmed as an output by setting the corresponding bit in the DDR. The DDR for Port A, B, C, and D are located at \$04, \$05, \$06 and, \$07 respectively. The DDRs are cleared by reset.

Note: A "glitch" may occur on an I/O pin when selecting from an input to an output unless the data register is first preconditioned to the desired state before changing the corresponding DDR bit from a "0" to a "1".

3.2 Port A — Keyboard Interrupts (KBI)

Port A is configured for use as keyboard interrupts when the KBIE bit is set in the Miscellaneous Control Register (MCR). Individual keyboard interrupt port pins are also maskable by setting corresponding bits in the Keyboard Interrupt Mask Register.

See Section 5.2.2.4 for details on the keyboard interrupts.

3.3 PD6 — $\overline{IRQ2}$

The port pin PD6 is configured as $\overline{IRQ2}$ by setting the IRQ2E bit in the MCR. The external interrupt $\overline{IRQ2}$ behaves similar to \overline{IRQ} except it is edge-triggered only, and does not have wake-up function in STOP mode.

See Section 5.2.2.2 for details on the external interrupt IRQ2.

INPUT/OUTPUT PORTS MC68HC05SU3A For More Information On This Product, Go to: www.freescale.com

3.4 Programmable Current Drive

All I/O ports (except PB0 and PB1), when programmed as outputs, can source or sink a current of 10mA for driving LEDs directly. By setting the PIL bit in the Port Option Register (at \$0A), PB5-PB7 can be programmed to a low-current mode that source or sink only a current of 2mA when programmed as output. This allows a direct drive to low current LEDs.

Note: Although the ports each has high current drive capability, designs should limit the total port currents to not more than 100mA.

3.5 Programmable Pull-Up Devices

Ports B, C, and D have $20K\Omega$ pull-up resistors, which can be connected or disconnected, by setting appropriate bits in the Port Option Register (at \$0A). Port pins PB0 and PB1 each has a permanent $1.9K\Omega$ pull-up resistor connected.

3.5.1 Port Option Register

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|-----------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|---|
| Port Option Register (POPR) | \$0A | | | PIL | PDP | PCP | PBP | | | 0000 0000 | 1 |

PIL — PB5:PB7 current drive select

- 1 (set) PB5-PB7 are configured to 2mA drive port.
- 0 (clear) PB5-PB7 are configured to 10mA drive port.

PDP — Port D Pull-up

- 1 (set) The internal $20K\Omega$ pull-up resistors are connected to the inputs of Port D.
- 0 (clear) No pull-up resistor is connected to the inputs of Port D.

PCP — Port C Pull-up

- 1 (set) The internal 20K Ω pull-up resistors are connected to the inputs of Port C.
- 0 (clear) No pull-up resistor is connected to the inputs of Port C.

PBP — PB2:PB7 Pull-up

- 1 (set) The internal $20K\Omega$ pull-up resistors are connected to the inputs of PB2-PB7.
- 0 (clear) No pull-up resistor is connected to the inputs of PB2-PB7.

MC68HC05SU3A

INPUT/OUTPUT PORTS For More Information On This Product, Go to: www.freescale.com

THIS PAGE LEFT BLANK INTENTIONALLY



INPUT/OUTPUT PORTS MC68HC05SU3A For More Information On This Product, Go to: www.freescale.com

4 MEMORY AND REGISTERS

The MC68HC05SU3A has 8K-bytes of addressable memory, consisting of I/O registers, user ROM, user RAM, and self-check ROM. Figure 4-1 shows the memory map for MC68HC05SU3A device.

4.1 I/O Registers

The I/O, status and control registers are located within the first 16 bytes of memory, from \$0000 to \$000F. These are shown in the memory map in Figure 4-1; and a summary of the register outline is shown in Table 4-1. Reading from unimplemented bits will return unknown states, and writing to unimplemented bits will be ignored.

4.2 RAM

The user RAM (including the stack) consists of 192 bytes. It is separated into two blocks at locations \$0010 to \$008F, and \$00C0 to \$00FF. The stack begins at address \$00FF and proceeds down to \$00C0.

4.3 ROM

The user ROM consists of 3840 bytes of memory, from \$1000 to \$1EFF. Twelve bytes of user vectors are also available, from \$1FF4 to \$1FFF.

Note: Using the stack area for data storage or temporary work locations requires care to prevent the data from being overwritten due to stacking from an interrupt or subroutine call.

MEMORY AND REGISTERS For More Information On This Product, Go to: www.freescale.com

4.4 Memory Map

Figure 4-1 shows the memory map for MC68HC05SU3A device.

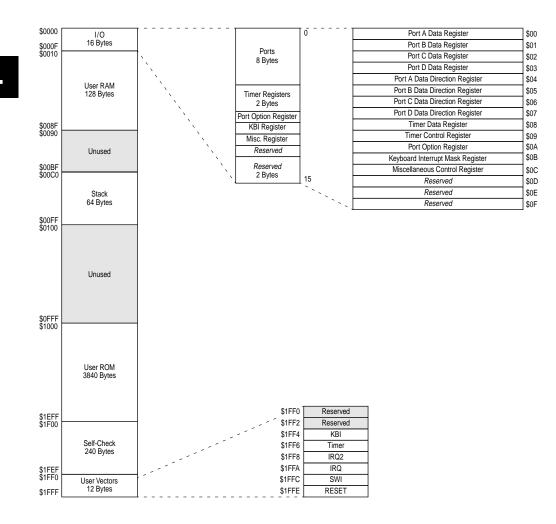


Figure 4-1 MC68HC05SU3A Memory Map

4.5 I/O Registers Summary

Table 4-1 shows a summary of I/O registers for MC68HC05SU3A device.

| Register Name | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset |
|-----------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|
| Port A Data | \$00 | PA7 | PA6 | PA5 | PA4 | PA3 | PA2 | PA1 | PA0 | unaffected |
| Port B Data | \$01 | PB7 | PB6 | PB5 | PB4 | PB3 | PB2 | PB1 | PB0 | unaffected |
| Port C Data | \$02 | PC7 | PC6 | PC5 | PC4 | PC3 | PC2 | PC1 | PC0 | unaffected |
| Port D Data | \$03 | PD7 | PD6 | PD5 | PD4 | PD3 | PD2 | PD1 | PD0 | unaffected |
| Port A Data Direction | \$04 | DDRA7 | DDRA6 | DDRA5 | DDRA4 | DDRA3 | DDRA2 | DDRA1 | DDRA0 | 0000 0000 |
| Port B Data Direction | \$05 | DDRB7 | DDRB6 | DDRB5 | DDRB4 | DDRB3 | DDRB2 | DDRB1 | DDRB0 | 0000 0000 |
| Port C Data Direction | \$06 | DDRC7 | DDRC6 | DDRC5 | DDRC4 | DDRC3 | DDRC2 | DDRC1 | DDRC0 | 0000 0000 |
| Port D Data Direction | \$07 | DDRD7 | DDRD6 | DDRD5 | DDRD4 | DDRD3 | DDRD2 | DDRD1 | DDRD0 | 0000 0000 |
| Timer Data (TDR) | \$08 | TD7 | TD6 | TD5 | TD4 | TD3 | TD2 | TD1 | TD0 | 1111 1111 |
| Timer Control (TCR) | \$09 | TIF | TIM | TCEX | TINE | PRER | PR2 | PR1 | PR0 | 0100 -000 |
| Port Option (POPR) | \$0A | | | PIL | PDP | PCP | PBP | | | 00 00 |
| KBI Mask (KBIM) | \$0B | KBE7 | KBE6 | KBE5 | KBE4 | KBE3 | KBE2 | KBE1 | KBE0 | 0000 0000 |
| Miscellaneous Control (MCR) | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 |
| Reserved | \$0D | | | | | | | | | |
| Reserved | \$0E | | | | | | | | | |
| Reserved | \$0F | | | | | | | | | |

MEMORY AND REGISTERS For More Information On This Product, Go to: www.freescale.com

Δ



THIS PAGE LEFT BLANK INTENTIONALLY

5 RESETS AND INTERRUPTS

This section describes the reset and interrupt functions on the MCU.

5.1 RESETS

The MC68HC05SU3A can be reset in three ways:

- by initial Power-On Reset function, (POR)
- by an active low input to the RESET pin, (RESET)
- by a Low Voltage Reset, (LVR)

All of these resets will cause the program to go to the starting address, specified by the contents of memory locations \$1FFE and \$1FFF, and cause the interrupt mask (I-bit) of the Condition Code Register (CCR) to be set.

5.1.1 Power-On Reset (POR)

The power-on reset (POR) occurs on power-up to allow the clock oscillator to stabilize. The POR is strictly for power-up conditions, and should not be used to detect any drops in power supply voltage.

There is an oscillator stabilization delay of t_{PORL} internal processor bus clock cycles after the oscillator becomes active. The RESET pin will be pulled down internally during these cycles. If the RESET pin is low (by external circuit) at the end of the t_{PORL} period, the processor remains in the reset condition until RESET goes high.

5.1.2 RESET Pin

The $\overline{\text{RESET}}$ input pin is used to reset the MCU to provide an orderly software start-up procedure. When using the external reset, the $\overline{\text{RESET}}$ pin must stay low for a minimum of 1.5t_{CYC}. The $\overline{\text{RESET}}$ pin is connected to a Schmitt Trigger circuit as part of its input to improve noise immunity.

MC68HC05SU3A

RESETS AND INTERRUPTS For More Information On This Product, Go to: www.freescale.com

5.1.3 Low Voltage Reset (LVR)

When the LVR function is enabled, an internal reset is generated if the supply voltage, V_{DD} , drops below V_{LVR} . (See Section 11 for value of V_{LVR}).

This LVR function is enabled by setting the LVRE bit in the Miscellaneous Control Register.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|--------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| Miscellaneous Control Register | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 | |

LVRE — Low Voltage Reset Enable

- 1 (set) Low Voltage Reset function enabled.
- 0 (clear) Low Voltage Reset function disabled.

5.2 INTERRUPTS

The MC68HC05SU3A MCU can be interrupted by different sources – four maskable hardware interrupt and one non-maskable software interrupt:

- Software Interrupt Instruction (SWI)
- External signal on IRQ pin
- External signal on IRQ2 pin
- TImer Overflow
- Keyboard

If the interrupt mask bit (I-bit) in the Condition Code Register (CCR) is set, all maskable interrupts are disabled. Clearing the I-bit enables interrupts.

Interrupts cause the processor to save the register contents on the stack and to set the interrupt mask (I-bit) to prevent additional interrupts. The RTI instruction causes the register contents to be recovered from the stack and normal processing to resume.

Unlike reset, hardware interrupts do not cause the current instruction execution to be halted, but are considered pending until the current instruction is complete. The current instruction is the one already fetched and being operated on. When the current instruction is complete, the processor checks all pending hardware interrupts. If interrupts are not masked (CCR I-bit clear) the processor proceeds with interrupt processing; otherwise, the next instruction is fetched and executed. Table 5-1 shows the relative priority of all the possible interrupt sources. Figure 5-2 shows the interrupt processing flow.

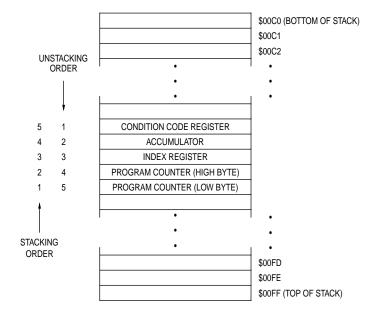


Figure 5-1 Interrupt Stacking Order

| Register | Flag Name | Interrupt | CPU Interrupt | Vector Address | Priority |
|----------|-----------|----------------------|---------------|----------------|----------|
| — | _ | Reset | RESET | \$1FFE-\$1FFF | highest |
| — | _ | Software | SWI | \$1FFC-\$1FFD |] ▲ |
| — | _ | External Interrupt | ĪRQ | \$1FFA-\$1FFB | |
| — | — | External Interrupt 2 | IRQ2 | \$1FF8-\$1FF9 | |
| TCR | TIF | Timer Overflow | TIF | \$1FF6-\$1FF7 | |
| — | — | Keyboard | KBI | \$1FF4-\$1FF5 | lowest |

5.2.1 Non-maskable Software Interrupt (SWI)

The software interrupt (SWI) is an executable instruction and a non-maskable interrupt: it is execute regardless of the state of the I-bit in the CCR. If the I-bit is zero (interrupt enabled), SWI is executed after interrupts that were pending when the SWI was fetched, but before interrupts generated after the SWI was fetched. The SWI interrupt service routine address is specified by the contents of memory locations \$1FFC and \$1FFD.

<u>L</u>

miconduct

1

0

eesca

RESETS AND INTERRUPTS For More Information On This Product, Go to: www.freescale.com

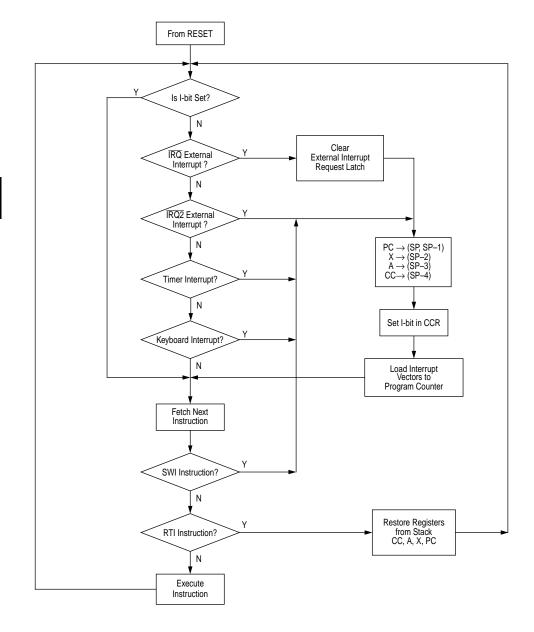


Figure 5-2 Hardware Interrupt Processing Flowchart

H.

emiconduc

Ń

Freescale

5.2.2 Maskable Hardware Interrupts

If the interrupt mask bit (I-bit) of the CCR is set, all maskable interrupts are masked. Clearing the I-bit allows interrupt processing to occur.

Note: The internal interrupt latch is cleared in the first part of the interrupt service routine; therefore, one external interrupt pulse could be latched and serviced as soon as the I-bit is cleared.

5.2.2.1 External Interrupt (IRQ)

The external interrupt IRQ is controlled by two bits in the Miscellaneous Control Register (\$0C).

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset |
|--------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|
| Miscellaneous Control Register | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 |

INTE — **INTerrupt** Enable

Ū

Semiconductor,

Freescale

- 1 (set) External interrupt IRQ is enabled.
- 0 (clear) External interrupt is disabled.

The external \overline{IRQ} is default enabled at power-on reset.

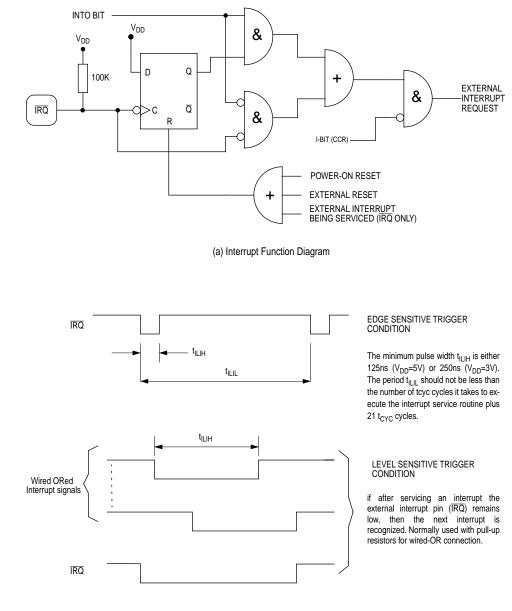
INTO — **INTerrupt** Option

- 1 (set) Negative-edge sensitive triggering for IRQ.
- 0 (clear) Negative-level sensitive triggering for IRQ.

When the signal of the external interrupt pin, \overline{IRQ} , satisfies the condition selected, an external interrupt occurs. The actual processor interrupt is generated only if the interrupt mask bit of the condition code register is also cleared. When the interrupt is recognized, the current state of the processor is pushed onto the stack and the interrupt mask bit in the Condition Code Register is set. This masks further interrupts until the present one is serviced. The service routine address is specified by the contents in \$1FFA-\$1FFB.

The interrupt logic recognizes negative edge transitions and pulses (special case of negative edges) on the external interrupt line. Figure 5-3 shows both a block diagram and timing for the interrupt line (IRQ) to the processor. The first method is used if pulses on the interrupt line are spaced far enough apart to be serviced. The minimum time between pulses is equal to the number of cycles required to execute the interrupt service routine plus 21 cycles. Once a pulse occurs, the next pulse should not occur until the MCU software has exited the routine (an RTI occurs). The second configuration shows several interrupt lines wired-OR to perform the interrupt at the processor. Thus, if the interrupt lines remain low after servicing one interrupt, the next interrupt is recognized.

RESETS AND INTERRUPTS For More Information On This Product, Go to: www.freescale.com



(b) Interrupt Mode Diagram

Figure 5-3 External Interrupt

MC68HC05SU3A

5.2.2.2 External Interrupt 2 (IRQ2)

The port pin PD6 is configured as IRQ2 by setting the IRQ2E bit in the MCR. The external interrupt IRQ2 behaves similar to IRQ except it is edge-triggered only, and does not have wake-up function in STOP mode.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset |
|--------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|
| Miscellaneous Control Register | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 |

IRQ2E — IRQ2 Enable

- 1 (set) External interrupt IRQ2 is enabled.
- 0 (clear) External interrupt IRQ2 is disabled.

IRQ2F — IRQ2 Flag clear

This is a write-only bit and always read as "0".

- 1 (set) Writing a "1" clears the IRQ2 interrupt latch.
- 0 (clear) Writing a "0" has no effect.

When a negative-edge is sensed on IRQ2 pin, an external interrupt occurs. The actual processor interrupt is generated only if the I-bit in the CCR is also cleared. When the interrupt is recognized, the current state of the processor is pushed onto the stack and the I-bit in the CCR is set. This masks further interrupts until the present one is serviced. The latch for IRQ2 is cleared by reset or by writing a "1" to the IRQ2F bit in the MCR in the interrupt service routine. The interrupt service routine address is specified by the contents in \$1FF8-\$1FF9.

5.2.2.3 Timer Interrupt

The timer interrupt is generated by the 8-bit timer when a timer overflow has occurred. The interrupt enable and flag for the timer interrupt are located in the Timer Control Register.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| Timer Control Register (TCR) | \$09 | TIF | ТІМ | TCEX | TINE | PREP | PR2 | PR1 | PR0 | 0100 -100 | |

TIM — Timer Interrupt Mask

- 1 (set) Timer interrupt is disabled.
- 0 (clear) Timer interrupt is enabled.

RESETS AND INTERRUPTS For More Information On This Product, Go to: www.freescale.com

TIF — Timer Interrupt Flag

- 1 (set) A timer interrupt (timer overflow) has occurred.
- 0 (clear) A timer interrupt (timer overflow) has not occurred.

The I-bit in the CCR must be cleared in order for the timer interrupt to be processed. The interrupt will vector to the interrupt service routine at the address specified by the contents in \$1FF6-\$1FF7.

5.2.2.4 Keyboard Interrupt (KBI)

Keyboard interrupt function is associated with Port A pins. The keyboard interrupt function is enabled by setting the keyboard interrupt enable bit KBIE (bit 7 of MCR at \$0C) and the individual enable bits KBE0-KBE7 (bits 0-7 of KBIM at \$0B). When the KBEx bit is set, the corresponding Port A pin will be configured as an input pin, regardless of the DDR setting, and a $20K\Omega$ pull-up resistor is connected to the pin, as shown in Figure 5-4. When a high to low transition is sensed on the pin, a keyboard interrupt will be generated. An interrupt to the CPU will be generated if the I-bit in the CCR is cleared.

The keyboard interrupt flag should be cleared in the interrupt service routine (by writing a "1" to KBIC bit in the MCR at \$0C) after the key is debounced. Debouncing will avoid spurious false triggering.

The keyboard interrupt is negative-edge sensitive only, and the interrupt service routine is specified by the contents in \$1FF4-\$1FF5.

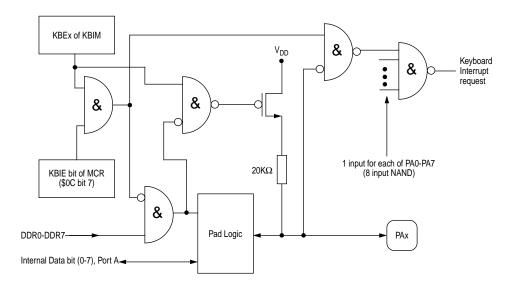


Figure 5-4 Keyboard Interrupt Circuitry

5-8

The KBIE bit in the Miscellaneous Control Register controls the master enable for the keyboard interrupts.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | on reset | |
|--------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-----------|---|
| Miscellaneous Control Register | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 |] |

KBIE — KeyBoard Interrupt Enable

- 1 (set) Keyboard interrupts master enabled.
- 0 (clear) Keyboard interrupts master disabled.

KBIC — KeyBoard Interrupt Clear

This is a write-only bit and always read as "0".

- 1 (set) Writing a "1" clears the keyboard interrupt latch.
- 0 (clear) Writing a "0" has no effect.

The Keyboard Interrupt Mask Register (KBIMR) masks individual keyboard interrupt pins and setting of the internal pull-up resistors on port A.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|-------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| KBIMR | \$0B | KBE7 | KBE6 | KBE5 | KBE4 | KBE3 | KBE2 | KBE1 | KBE0 | 0000 0000 | |

KBEx — PAx Keyboard Interrupt Enable

- (set) Keyboard interrupt enabled for PAx. A 20KΩ internal pull-up resistor is connected. High to low transition on PAx will cause a keyboard interrupt.
- 0 (clear) Keyboard interrupt for PAx pin is masked. Any transitions on PAx will not set any flags.

n



THIS PAGE LEFT BLANK INTENTIONALLY

6 TIMER

This section describes the operation of the 8-bit count-down timer in the MC68HC05SU3A.

6.1 Timer Overview

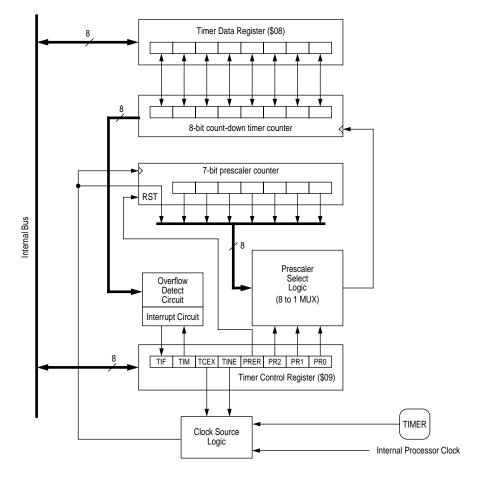
The MC68HC05SU3A timer block diagram is shown in Figure 6-1. The timer contains a single 8-bit software programmable count-down counter with a 7-bit software selectable prescaler. The counter may be preset under software control and decrements towards zero. When the counter decrements to zero, the timer interrupt flag (TIF bit in Timer Control Register, TCR) is set. Once timer interrupt flag is set, an interrupt is generated to the CPU only if the TIM bit in the TCR and I-bit in the CCR are cleared. When a interrupt is recognized, after completion of the current instruction, the processor proceeds to store the appropriate registers on the stack and then fetches the timer interrupt vector from locations \$1FF6 and \$1FF7.

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external clocks since the timer interrupt flag was set. The counter may be read at any time by the processor without disturbing the count. The contents of the counter become stable prior to the read portion of a cycle and do not change during the read. The timer interrupt flag remains set until cleared by the software. If a write occurs before the timer interrupt is served, the interrupt is lost. The timer interrupt flag may also be used as a scanned status bit in a non-interrupt mode of operation.

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer. Bit 0, 1, 2 (PR0, PR1, PR2) of TCR are programmed to choose the appropriate prescaler output which is used as the 8-bit counter clock input. The processor cannot write into or read from the prescaler; however, its contents can be cleared to all zeros by writing to the PRER bit in the TCR. This will allow for truncation-free counting.

The input clock for the timer sub-system is selectable from internal, external, or a combination of internal and external sources. The TCEX and TINE bits in the Timer Control Register selects the timer input clock.

TIMER For More Information On This Product, Go to: www.freescale.com



| TCEX | TINE | Clock Source |
|------|------|------------------------------------------------|
| 0 | 0 | Internal clock to timer |
| 0 | 1 | "AND" of internal clock and TIMER pin to timer |
| 1 | 0 | Input clock to timer disabled |
| 1 | 1 | TIMER pin to timer |

Figure 6-1 Timer Block Diagram

01,

Freescale Semicond

6.2 Timer Control Register (TCR)

The TCR enables the software to control the operation of the timer.

| Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| \$09 | TIF | ТІМ | TCEX | TINE | PRER | PRE2 | PRE1 | PRE0 | 0100 -100 | |

TIF — Timer Interrupt Flag

1 (set) - The timer has reached a count of zero.

0 (clear) - The timer has not reached a count of zero.

The timer interrupt flag is set when the 8-bit counter decrements to zero. This bit is cleared on reset, or by writing a "0" to the TIF bit.

TIM — Timer Interrupt Mask

- 1 (set) Timer interrupt request to the CPU is masked (disabled).
- 0 (clear) Timer interrupt request to the CPU is not masked (enabled).

A reset sets this bit to one; it must then be cleared by software to enable the timer interrupt to the CPU. This timer interrupt mask only masks timer interrupt request to the CPU, and does not affect counting of the 8-bit counter or the setting of TIF.

TCEX — Timer Clock EXternal TINE — Timer INput Enable

These two bits selects the source of the timer clock. Reset or power-on clears these bits to zero.

| TCEX | TINE | Clock Source |
|------|------|------------------------------------------------|
| 0 | 0 | Internal clock to timer |
| 0 | 1 | "AND" of internal clock and TIMER pin to timer |
| 1 | 0 | Input clock to timer disabled |
| 1 | 1 | TIMER pin to timer |

PRER — PREscaler Reset

Writing a "1" to this write-only bit will reset the prescaler to zero, which is necessary for any new counts set by writing to the Timer Data Register. This bit always reads as zero, and is not affected by reset.

TIMER For More Information On This Product, Go to: www.freescale.com

PR2:PR0

These three bits enable the program to select the division ratio of the prescaler. On reset, these three bits are set to "100", which corresponds to a division ratio of 16.

| PR2 | PR1 | PR0 | Divide Ratio |
|-----|-----|-----|--------------|
| 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | 0 | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |

6.3 Timer Data Register (TDR)

The TDR is a read/write register which contains the current value of the 8-bit count-down timer counter when read. Reading this register does not disturb the counter operation.

| Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| \$08 | TD7 | TD6 | TD5 | TD4 | TD3 | TD2 | TD1 | TD0 | 1111 1111 | |

6.4 Operation during Low Power Modes

The timer ceases counting in STOP mode. When STOP mode is exited by an external interrupt (\overline{IRQ} or KBI), the internal oscillator will resume its operation, followed by internal processor stabilization delay. The timer is then cleared to zero and resumes its operation. The TIF bit in the TCR will be set. To avoid generating a timer interrupt when exiting STOP mode, it is recommended to set the TIM bit prior entering STOP mode. After exiting STOP mode TIF bit can then be cleared.

The CPU clock halts during the WAIT mode, but the timer remains active. If the interrupts are enabled, the timer interrupt will cause the processor to exit the WAIT mode.

7 CPU CORE AND INSTRUCTION SET

This section provides a description of the CPU core registers, the instruction set and the addressing modes of the MC68HC05SU3A.

7.1 Registers

The MCU contains five registers, as shown in the programming model of Figure 7-1. The interrupt stacking order is shown in Figure 7-2.

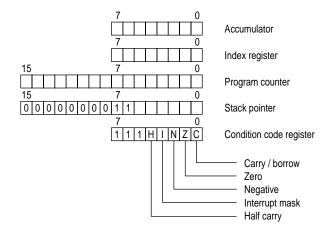


Figure 7-1 Programming model

7.1.1 Accumulator (A)

The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

MC68HC05SU3A

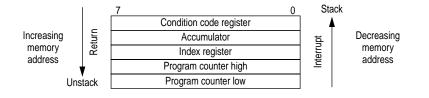


Figure 7-2 Stacking order

7.1.2 Index register (X)

The index register is an 8-bit register, which can contain the indexed addressing value used to create an effective address. The index register may also be used as a temporary storage area.

7.1.3 Program counter (PC)

The program counter is a 16-bit register, which contains the address of the next byte to be fetched.

7.1.4 Stack pointer (SP)

The stack pointer is a 16-bit register, which contains the address of the next free location on the stack. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location \$00FF. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is pulled from the stack.

When accessing memory, the ten most significant bits are permanently set to 0000000011. These ten bits are appended to the six least significant register bits to produce an address within the range of \$00C0 to \$00FF. Subroutines and interrupts may use up to 64 (decimal) locations. If 64 locations are exceeded, the stack pointer wraps around and overwrites the previously stored information. A subroutine call occupies two locations on the stack; an interrupt uses five locations.

7.1.5 Condition code register (CCR)

The CCR is a 5-bit register in which four bits are used to indicate the results of the instruction just executed, and the fifth bit indicates whether interrupts are masked. These bits can be individually tested by a program, and specific actions can be taken as a result of their state. Each bit is explained in the following paragraphs.

Half carry (H)

This bit is set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4.

Interrupt (I)

When this bit is set, all maskable interrupts are masked. If an interrupt occurs while this bit is set, the interrupt is latched and remains pending until the interrupt bit is cleared.

Negative (N)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative.

Zero (Z)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

Carry/borrow (C)

When set, this bit indicates that a carry or borrow out of the arithmetic logical unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions and during shifts and rotates.

7.2 Instruction set

The MCU has a set of 62 basic instructions. They can be grouped into five different types as follows:

- Register/memory
- Read/modify/write
- Branch
- Bit manipulation
- Control

The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

This MCU uses all the instructions available in the M146805 CMOS family plus one more: the unsigned multiply (MUL) instruction. This instruction allows unsigned multiplication of the contents of the accumulator (A) and the index register (X). The high-order product is then stored in the index register and the low-order product is stored in the accumulator. A detailed definition of the MUL instruction is shown in Table 7-1.

7.2.1 Register/memory Instructions

Most of these instructions use two operands. The first operand is either the accumulator or the index register. The second operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 7-2 for a complete list of register/memory instructions.

7.2.2 Branch instructions

These instructions cause the program to branch if a particular condition is met; otherwise, no operation is performed. Branch instructions are two-byte instructions. Refer to Table 7-3.

7.2.3 Bit manipulation instructions

The MCU can set or clear any writable bit that resides in the first 256 bytes of the memory space (page 0). All port data and data direction registers, timer and serial interface registers, control/status registers and a portion of the on-chip RAM reside in page 0. An additional feature allows the software to test and branch on the state of any bit within these locations. The bit set, bit clear, bit test and branch functions are all implemented with single instructions. For the test and branch instructions, the value of the bit tested is also placed in the carry bit of the condition code register. Refer to Table 7-4.

7.2.4 Read/modify/write instructions

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to this sequence of reading, modifying and writing, since it does not modify the value. Refer to Table 7-5 for a complete list of read/modify/write instructions.

7.2.5 Control instructions

These instructions are register reference instructions and are used to control processor operation during program execution. Refer to Table 7-6 for a complete list of control instructions.

7.2.6 Tables

Tables for all the instruction types listed above follow. In addition there is a complete alphabetical listing of all the instructions (see Table 7-7), and an opcode map for the instruction set of the M68HC05 MCU family (see Table 7-8).

```
Freescale Semiconductor, Inc.
```

| Operation | $X:A \leftarrow X^*A$ | | | | | | | |
|--------------------|-------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| Description | bits in the accumulator a | Multiplies the eight bits in the index register by the eight bits in the accumulator and places the 16-bit result in the concatenated accumulator and index register. | | | | | | |
| Condition codes | I : N N : N Z : N | H : Cleared I : Not affected N : Not affected Z : Not affected C : Cleared | | | | | | |
| Source | | MUL | | | | | | |
| Form | Addressing modeCyclesBytesOpcodeInherent111\$42 | | | | | | | |

Table 7-1 MUL instruction

| Table 7-2 | Register/memory instructions |
|-----------|------------------------------|
|-----------|------------------------------|

| | | | Addressing modes | | | | | | | | | | | | | | | | |
|------------------------------------------|-----------|--------|------------------|----------|--------|---------|----------|--------|---------|---------------------------|--------|---------|------------------------------|--------|---------|-------------------------------|--------|---------|----------|
| | Immediate | | | | Direct | | E | tend | ed | Indexed (no offset) | | | Indexed (8-bit offset) | | | Indexed (16-bit offset) | | t | |
| Function | Mnemonic | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles |
| Load A from memory | LDA | A6 | 2 | 2 | B6 | 2 | 3 | C6 | 3 | 4 | F6 | 1 | 3 | E6 | 2 | 4 | D6 | 3 | 5 |
| Load X from memory | LDX | AE | 2 | 2 | BE | 2 | 3 | CE | 3 | 4 | FE | 1 | 3 | EE | 2 | 4 | DE | 3 | 5 |
| Store A in memory | STA | | | | B7 | 2 | 4 | C7 | 3 | 5 | F7 | 1 | 4 | E7 | 2 | 5 | D7 | 3 | 6 |
| Store X in memory | STX | | | | BF | 2 | 4 | CF | 3 | 5 | FF | 1 | 4 | EF | 2 | 5 | DF | 3 | 6 |
| Add memory to A | ADD | AB | 2 | 2 | BB | 2 | 3 | CB | 3 | 4 | FB | 1 | 3 | EB | 2 | 4 | DB | 3 | 5 |
| Add memory and carry to A | ADC | A9 | 2 | 2 | B9 | 2 | 3 | C9 | 3 | 4 | F9 | 1 | 3 | E9 | 2 | 4 | D9 | 3 | 5 |
| Subtract memory | SUB | A0 | 2 | 2 | B0 | 2 | 3 | C0 | 3 | 4 | F0 | 1 | 3 | E0 | 2 | 4 | D0 | 3 | 5 |
| Subtract memory from A with borrow | SBC | A2 | 2 | 2 | B2 | 2 | 3 | C2 | 3 | 4 | F2 | 1 | 3 | E2 | 2 | 4 | D2 | 3 | 5 |
| AND memory with A | AND | A4 | 2 | 2 | B4 | 2 | 3 | C4 | 3 | 4 | F4 | 1 | 3 | E4 | 2 | 4 | D4 | 3 | 5 |
| OR memory with A | ORA | AA | 2 | 2 | BA | 2 | 3 | CA | 3 | 4 | FA | 1 | 3 | EA | 2 | 4 | DA | 3 | 5 |
| Exclusive OR memory with A | EOR | A8 | 2 | 2 | B8 | 2 | 3 | C8 | 3 | 4 | F8 | 1 | 3 | E8 | 2 | 4 | D8 | 3 | 5 |
| Arithmetic compare A with memory | CMP | A1 | 2 | 2 | B1 | 2 | 3 | C1 | 3 | 4 | F1 | 1 | 3 | E1 | 2 | 4 | D1 | 3 | 5 |
| Arithmetic compare X with memory | СРХ | A3 | 2 | 2 | B3 | 2 | 3 | C3 | 3 | 4 | F3 | 1 | 3 | E3 | 2 | 4 | D3 | 3 | 5 |
| Bit test memory with A (logical compare) | BIT | A5 | 2 | 2 | B5 | 2 | 3 | C5 | 3 | 4 | F5 | 1 | 3 | E5 | 2 | 4 | D5 | 3 | 5 |
| Jump unconditional | JMP | | | | BC | 2 | 2 | CC | 3 | 3 | FC | 1 | 2 | EC | 2 | 3 | DC | 3 | 4 |
| Jump to subroutine | JSR | | | | BD | 2 | 5 | CD | 3 | 6 | FD | 1 | 5 | ED | 2 | 6 | DD | 3 | 7 |

| | | Relative | addressi | ng mode |
|---------------------------------------|----------|----------|----------|----------|
| Function | Mnemonic | Opcode | # Bytes | # Cycles |
| Branch always | BRA | 20 | 2 | 3 |
| Branch never | BRN | 21 | 2 | 3 |
| Branch if higher | BHI | 22 | 2 | 3 |
| Branch if lower or same | BLS | 23 | 2 | 3 |
| Branch if carry clear | BCC | 24 | 2 | 3 |
| (Branch if higher or same) | (BHS) | 24 | 2 | 3 |
| Branch if carry set | BCS | 25 | 2 | 3 |
| (Branch if lower) | (BLO) | 25 | 2 | 3 |
| Branch if not equal | BNE | 26 | 2 | 3 |
| Branch if equal | BEQ | 27 | 2 | 3 |
| Branch if half carry clear | BHCC | 28 | 2 | 3 |
| Branch if half carry set | BHCS | 29 | 2 | 3 |
| Branch if plus | BPL | 2A | 2 | 3 |
| Branch if minus | BMI | 2B | 2 | 3 |
| Branch if interrupt mask bit is clear | BMC | 2C | 2 | 3 |
| Branch if interrupt mask bit is set | BMS | 2D | 2 | 3 |
| Branch if interrupt line is low | BIL | 2E | 2 | 3 |
| Branch if interrupt line is high | BIH | 2F | 2 | 3 |
| Branch to subroutine | BSR | AD | 2 | 6 |

| Table 7-3 | Branch instructions | |
|-----------|---------------------|--|
|-----------|---------------------|--|

 Table 7-4
 Bit manipulation instructions

| | | Addressing modes | | | | | | | | |
|--------------------------|-----------------|------------------|-------------------------------|----------|--------|---------|----------|--|--|--|
| | | E | Bit set/clear Bit test and br | | | | | | | |
| Function | Mnemonic | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | | | |
| Branch if bit n is set | BRSET n (n=0-7) | | | | 2•n | 3 | 5 | | | |
| Branch if bit n is clear | BRCLR n (n=0-7) | | | | 01+2•n | 3 | 5 | | | |
| Set bit n | BSET n (n=0-7) | 10+2•n | 2 | 5 | | | | | | |
| Clear bit n | BCLR n (n=0-7) | 11+2•n | 2 | 5 | | | | | | |

| | | | | | | | A | ddressing modes | | | | | | | | | |
|----------------------------|----------|-----------------|---------|----------|-----------------|---------|----------|-----------------|---------|----------|---------------------------|---------|----------|------------------------------|---------|----------|--|
| | | Inherent (A) | | | Inherent (X) | | | Direct | | | Indexed (no offset) | | | Indexed (8-bit offset) | | | |
| Function | Mnemonic | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | Opcode | # Bytes | # Cycles | |
| Increment | INC | 4C | 1 | 3 | 5C | 1 | 3 | 3C | 2 | 5 | 7C | 1 | 5 | 6C | 2 | 6 | |
| Decrement | DEC | 4A | 1 | 3 | 5A | 1 | 3 | 3A | 2 | 5 | 7A | 1 | 5 | 6A | 2 | 6 | |
| Clear | CLR | 4F | 1 | 3 | 5F | 1 | 3 | 3F | 2 | 5 | 7F | 1 | 5 | 6F | 2 | 6 | |
| Complement | COM | 43 | 1 | 3 | 53 | 1 | 3 | 33 | 2 | 5 | 73 | 1 | 5 | 63 | 2 | 6 | |
| Negate (two's complement) | NEG | 40 | 1 | 3 | 50 | 1 | 3 | 30 | 2 | 5 | 70 | 1 | 5 | 60 | 2 | 6 | |
| Rotate left through carry | ROL | 49 | 1 | 3 | 59 | 1 | 3 | 39 | 2 | 5 | 79 | 1 | 5 | 69 | 2 | 6 | |
| Rotate right through carry | ROR | 46 | 1 | 3 | 56 | 1 | 3 | 36 | 2 | 5 | 76 | 1 | 5 | 66 | 2 | 6 | |
| Logical shift left | LSL | 48 | 1 | 3 | 58 | 1 | 3 | 38 | 2 | 5 | 78 | 1 | 5 | 68 | 2 | 6 | |
| Logical shift right | LSR | 44 | 1 | 3 | 54 | 1 | 3 | 34 | 2 | 5 | 74 | 1 | 5 | 64 | 2 | 6 | |
| Arithmetic shift right | ASR | 47 | 1 | 3 | 57 | 1 | 3 | 37 | 2 | 5 | 77 | 1 | 5 | 67 | 2 | 6 | |
| Test for negative or zero | TST | 4D | 1 | 3 | 5D | 1 | 3 | 3D | 2 | 4 | 7D | 1 | 4 | 6D | 2 | 5 | |
| Multiply | MUL | 42 | 1 | 11 | | | | | | | | | | | | | |

| Table 7-5 | Read/modify/write instructions |
|-----------|--------------------------------|
|-----------|--------------------------------|

Table 7-6 Control instructions

| | | Inherent | addressi | ng mode |
|--------------------------|----------|----------|----------|----------|
| Function | Mnemonic | Opcode | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set carry bit | SEC | 99 | 1 | 2 |
| Clear carry bit | CLC | 98 | 1 | 2 |
| Set interrupt mask bit | SEI | 9B | 1 | 2 |
| Clear interrupt mask bit | CLI | 9A | 1 | 2 |
| Software interrupt | SWI | 83 | 1 | 10 |
| Return from subroutine | RTS | 81 | 1 | 6 |
| Return from interrupt | RTI | 80 | 1 | 9 |
| Reset stack pointer | RSP | 9C | 1 | 2 |
| No-operation | NOP | 9D | 1 | 2 |
| Stop | STOP | 8E | 1 | 2 |
| Wait | WAIT | 8F | 1 | 2 |

| Mnemonic | | | | | Idressi | ng moo | | | | | Condition codes | | | | | | |
|------------|-----|-----|-----|-----|---------|--------|-----|-----|-----|-----|-----------------|---|---|---|---|--|--|
| Millemonic | INH | IMM | DIR | EXT | REL | IX | IX1 | IX2 | BSC | BTB | Н | Ι | Ν | Z | C | | |
| ADC | | | | | | | | | | | ٥ | • | 0 | 0 | 0 | | |
| ADD | | | | | | | | | | | 0 | • | 0 | 0 | 0 | | |
| AND | | | | | | | | | | | • | • | 0 | 0 | • | | |
| ASL | | | | | | | | | | | • | • | 0 | 0 | 0 | | |
| ASR | | | | | | | | | | | • | • | 0 | 0 | 0 | | |
| BCC | | | | | | | | | | | • | • | • | • | • | | |
| BCLR | | | | | | | | | | | • | • | • | • | • | | |
| BCS | | | | | | | | | | | • | • | • | • | • | | |
| BEQ | | | | | | | | | | | • | • | • | • | • | | |
| BHCC | | | | | | | | | | | • | • | • | • | • | | |
| BHCS | | | | | | | | | | | • | • | • | • | • | | |
| BHI | | | | | | | | | | | • | • | • | • | • | | |
| BHS | | | | | | | | | | | • | • | • | • | • | | |
| BIH | | | | | | | | | | | • | • | • | • | • | | |
| BIL | | | | | | | | | | | • | • | • | • | • | | |
| BIT | | | | | | | | | | | • | • | 0 | 0 | • | | |
| BLO | | | | | | | | | | | • | • | • | • | • | | |
| BLS | | | | | | | | | | | • | • | • | • | • | | |
| BMC | | | | | | | | | | | • | • | • | • | • | | |
| BMI | | | | | | | | | | | • | • | • | • | • | | |
| BMS | | | | | | | | | | | • | • | • | • | • | | |
| BNE | | | | | | | | | | | • | • | • | • | • | | |
| BPL | | | | | | | | | | | • | • | • | • | • | | |
| BRA | | | | | | | | | | | • | • | • | • | • | | |
| BRN | | | | | | | | | | | • | • | • | • | • | | |
| BRCLR | | | | | | | | | | | • | • | • | • | 0 | | |
| BRSET | | | | | | | | | | | • | • | • | • | 0 | | |
| BSET | | | | | | | | | | | • | • | • | • | • | | |
| BSR | | | | | | | | | | | • | • | • | • | • | | |
| CLC | | | | | | | | | | | • | • | • | • | 0 | | |
| CLI | | | | | | | | | | | • | 0 | • | • | • | | |
| CLR | | | | | | | | | | | • | • | 0 | 1 | • | | |
| CMP | | | | | | | | | | | • | • | 0 | 0 | 0 | | |

| Address mo | ode abb | reviations |
|------------|---------|------------|
| ear | IMM | Immediate |

IX

- BSC Bit set/clear BTB Bit test & branch DIR Direct
- EXT Extended INH Inherent

IX2 Indexed, 2 byte offset REL Relative

Not implemented

Indexed (no offset)

IX1 Indexed, 1 byte offset

Condition code symbols Tested and set if true, H Half carry (from bit 3) ٥

- I Interrupt mask
- N Negate (sign bit)
- Z Zero
- C Carry/borrow
- Not affected ? Load CCR from stack 0 Cleared

cleared otherwise

•

1 Set

| Mnemonic | | | | Ac | Idressir | ng moo | des | | | | (| Condition codes | | | | | | |
|----------|-----|-----|-----|-----|----------|--------|-----|-----|-----|-----|---|-----------------|----|----|------------|--|--|--|
| whemonic | INH | IMM | DIR | EXT | REL | IX | IX1 | IX2 | BSC | BTB | Н | Ι | N | Z | C | | | |
| COM | | | | | | | | | | | • | • | 0 | 0 | 1 | | | |
| CPX | | | | | | | | | | | • | • | 0 | 0 | 0 | | | |
| DEC | | | | | | | | | | | • | • | 0 | \$ | • | | | |
| EOR | | | | | | | | | | | • | • | 0 | \$ | • | | | |
| INC | | | | | | | | | | | • | • | 0 | 0 | • | | | |
| JMP | | | | | | | | | | | • | • | • | • | • | | | |
| JSR | | | | | | | | | | | • | • | • | • | • | | | |
| LDA | | | | | | | | | | | • | • | 0 | 0 | • | | | |
| LDX | | | | | | | | | | | • | • | 0 | 0 | • | | | |
| LSL | | | | | | | | | | | • | • | 0 | 0 | \diamond | | | |
| LSR | | | | | | | | | | | • | • | 0 | 0 | \diamond | | | |
| MUL | | | | | | | | | | | 0 | • | • | • | 0 | | | |
| NEG | | | | | | | | | | | • | • | 0 | \$ | \diamond | | | |
| NOP | | | | | | | | | | | • | • | • | • | ٠ | | | |
| ORA | | | | | | | | | | | • | • | 0 | \$ | ٠ | | | |
| ROL | | | | | | | | | | | • | • | 0 | \$ | \diamond | | | |
| ROR | | | | | | | | | | | • | • | 0 | \$ | \diamond | | | |
| RSP | | | | | | | | | | | • | • | • | • | • | | | |
| RTI | | | | | | | | | | | ? | ? | ? | ? | ? | | | |
| RTS | | | | | | | | | | | • | • | • | • | ٠ | | | |
| SBC | | | | | | | | | | | • | • | \$ | \$ | \diamond | | | |
| SEC | | | | | | | | | | | • | • | • | • | 1 | | | |
| SEI | | | | | | | | | | | • | 1 | • | • | • | | | |
| STA | | | | | | | | | | | • | • | \$ | \$ | ٠ | | | |
| STOP | | | | | | | | | | | • | 0 | • | • | • | | | |
| STX | | | | | | | | | | | • | • | 0 | ♦ | • | | | |
| SUB | | | | | | | | | | | • | • | 0 | ♦ | \diamond | | | |
| SWI | | | | | | | | | | | • | 1 | • | • | • | | | |
| TAX | | | | | | | | | | | • | • | • | • | • | | | |
| TST | | | | | | | | | | | • | • | 0 | ♦ | • | | | |
| TXA | | | | | | | | | | | • | • | • | • | • | | | |
| WAIT | | | | | | | | | | | • | 0 | • | • | • | | | |

| Table 7-7 | Instruction set | (Continued) |
|-----------|-----------------|-------------|
|-----------|-----------------|-------------|

| Α | ddress | mode | abbreviations |
|---|--------|------|---------------|
| | | | |

| BSC | Bit set/clear | IMM | Immediate |
|-----|-------------------|-----|------------------------|
| BTB | Bit test & branch | IX | Indexed (no offset) |
| DIR | Direct | IX1 | Indexed, 1 byte offset |
| EXT | Extended | IX2 | Indexed, 2 byte offset |
| INH | Inherent | REL | Relative |
| | | | |

Condition code symbols

| Н | Half carry (from bit 3) | ٥ | Tested and set if true, cleared otherwise |
|---|-------------------------|---|----------------------------------------------|
| Т | Interrupt mask | • | Not affected |
| Ν | Negate (sign bit) | ? | Load CCR from stack |
| Ζ | Zero | 0 | Cleared |
| С | Carry/borrow | 1 | Set |

0 C

Freescale Semiconductor,

| | | High | 1 | 0000 | 3 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | 3 2 IX 0010 | 3 1x 0011 | 3 4 IX 0100 | 3 5 IX 0101 | ³ 6 _{IX} 0110 | 4 7 IX 0111 | 3 8 1000 | 3 1001 | 3 A 1010 | 3 B I 1011 | ² C C 1100 | 5 IX 1101 | ³ E _{IX} 1110 | 4 F IX 1111 | | Opcode in hexadecimal | |
|-------------------|-----|------|------|----------------------------------------------|----------------------------------------------|----------------------------------------------|------------------------------------------|--------------------------------------------|---------------------------|--------------------------------------|-------------------|----------------------------------------------|------------------------------------------|----------------------------------------------|-------------------------------|----------------------------------------------|------------------------------------------|----------------------------------------------|----------------------------------------------|-----------------------------------------------|------------------------------------------------------------------------------------------|----------|
| | × | ш | 1111 | 1 SUB | CMP | 3BC | CPX | AND | BIT | FDA | STA | EOR | ADC | 1 ORA | 4DD | JMP | JSR | | STX | | pcode in hexadeci Opcode in binary | |
| | IX1 | ш | 1110 | 2 SUB 4 | 2 CMP 4 | 2 SBC 4 | 2 CPX 4 | AND 4 | BIT 4 2 BIT 4 | 2 LDA 4 | STA 5 2 NIX | EOR 4 | ADC 4 | 2 ORA 4 | ADD 4 | JMP ³ | JSR ⁶ 2 ISR ^{1X1} | 2 LDX K1 | 2 STX 5 | | | <u> </u> |
| Register/memory | IX2 | | 1101 | 3 SUB 3 | 5 CMP 5 3 CMP 5 | 3 SBC 5 3 IX2 | CPX 5 3 CPX 5 | AND 5 3 AND 1x2 | BIT 5 3 BIT 5 | 3 LDA 5 3 IX2 | STA 6 3 IX2 | EOR 5 3 EOR | 3 ADC | ORA | ADD 5 3 ADD 1X2 | JMP 4 3 JMP 1X2 | JSR 7 3 JSR 1X2 | 3 LDX 5 | 3 STX ⁶ 3 STX 1X2 | | 1111 F | |
| Register | EXT | ပ | 1100 | 3 SUB 4 | 3 CMP 4 | 3 SBC 4 3 EXT | 3 CPX 4 3 EXT | 3 AND 4 EXT | BIT 4 | 3 LDA EXT | 3 STA 5 3 EXT | EOR 4 3 EOR | ADC | 3 ORA 4 EXT | 3 ADD 4 | 3 JMP ³ 3 EXT | JSR ⁶ 3 JSR ⁶ | 3 LDX EXT | 3 STX 5 | | 11 - | 7 |
| | DIR | ш | 1011 | 2 SUB 3 | CMP ³ 2 DIR | 2 SBC ³ | 2 CPX ³ | AND ³ | BIT ³ 2 DIR | 2 LDA DIR | 2 STA 4 | EOR ³ 2 DIR | ² ADC | 2 ORA ³ | ADD ³ 2 DIR | JMP ² 2 DIR | JSR ⁵ 2 DIR | 2 LDX DIR 3 | STX ⁴ 2 DIR | Legend | Mnemonic | |
| | MMI | A | 1010 | 2 SUB 2 MM | CMP ² 2 MM | 2 SBC 2 MM | CPX ² 2 MM | AND ² and ² | BIT ² 2 MM | 2 LDA MM | | EOR ² | ADC ² | 2 ORA MM | ADD ² 2 MM | | BSR ⁶ 2 BSR | 2 LDX 2 MM 2 | | Lec | | |
| Control | HNI | 6 | 1001 | | | | | | | | TAX ² | CLC ² | SEC ² | CLI ² | SEI ² | RSP ² | 1 NOP ² NOP ² | | TXA ² | | | |
| Con | HNI | 8 | 1000 | 1 RTI [«] | RTS ⁶ | | SWI ¹⁰ | | | | | | | | | | | STOP ² | WAIT ² | | | |
| | X | 7 | 0111 | NEG × | | | COM 5 | LSR 5 | | ROR 5 | ASR 5 | rSL 5 | ROL 5 | DEC 5 | | INC 5 | TST ⁴ | | CLR 5 | | | |
| fte | IX1 | 9 | 0110 | NEG | | | COM K1 | LSR 6 | | ROR 6 | ASR 6 | LSL 6 | ROL 6 | DEC | | INC 6 | TST 5 | | CLR 6 | | | |
| Read/modify/write | H | 2 | 0101 | NEGX ³ | | | COMX 3 | LSRX ³ | | RORX ³ | ASRX ³ | LSLX 3 | ROLX ³ | DECX 3 | | INCX 3 | TSTX ³ | | CLRX ³ | | t) 3-bit) offset 16-bit) offset | |
| Rea | HN | 4 | 0100 | NEGA ³ | | MUL [™] 1 | COMA ³ | LSRA ³ | | RORA ³ | ASRA ³ | LSLA ³ | ROLA ³ | DECA ³ | | INCA ³ | TSTA ³ | | CLRA ³ | | Indexed (no offset) Indexed, 1 byte (8-bit) offset Indexed, 2 byte (16-bit) offset | |
| | DIR | e | 0011 | NEG | | | COM 5 | LSR ⁵ | | ROR 5 | ASR 5 | LSL 5 | ROL | DEC | | INC 5 | TST ⁴ | | CLR 5 | | | |
| Branch | REL | 2 | 0010 | ² BRA ³ | BRN ³ REL | ² BHI ³ | BLS ³ BLS ^{8EL 2} | BCC BCC | | BNE ³ | BEQ ³ | BHCC ³ | BHCS | | ² BMI ³ | ² BMC ³ | ² BMS ³ | ² BIL ³ | ³ BIH ³ | nd registers | X X X | |
| oulation | BSC | - | 0001 | BSET0 ² 2 BSET0 ² | BCLR0 ⁵ 2 BCLR0 ⁵ | | BCLR1 5 | BSET2 ⁵ 2 BSET2 ⁵ | BCLR2 5 | BSET3 5 2 BSC 2 | BCLR3 5 | BSET4 5 2 BSET2 | BCLR4 ⁵ ² BSC 2 | | BCLR5 | BSET6 5 2 BSC 2 | BCLR6 ⁵ 2 BCLR6 | BSET7 ⁵ 2 BSET7 | BCLR7 ⁵ 2 BCLR7 ⁵ | ess modes a | vranch | |
| Bit manipulation | BTB | | 0000 | BRSET0 ³ 3 BRSET0 ² | BRCLR0 ⁵ 3 BRCLR0 ⁵ | BRSET1 ⁵ 3 BRSET1 ⁵ | BRCLR1 ⁵ | BRSET2 ⁵ 3 BRSET2 | BRCLR2 | BRSET3 | BRCLR3 | BRSET4 ⁵ 3 BRSET4 ⁵ | BRCLR4 | BRSET5 ⁵ 3 BRSET5 ⁵ | BRCLR5 | BRSET6 ⁵ 3 BRSET6 ⁵ | BRCLR6 ⁵ | BRSET7 ⁵ 3 BRSET7 ⁵ | BRCLR7 ⁵ 3 BRCLR7 ⁵ | Abbreviations for address modes and registers | Bit set/clear Bit test and branch Direct | |
| | | High | Low | 0000 | 1 0001 | 2 0010 | 3 0011 | 4 0100 | 5 0101 | 6 0110 | 7 0111 | 8 1000 | 9 1001 | A 1010 | 1011 1011 | 1100 1100 | 1101 1101 | E 1110 | F 1111 | Abbreviati | BSC BTB DIR | |

Table 7-8 M68HC05 opcode map



| ndexed (no offset) | byte (8-bit) offset | Indexed, 2 byte (16-bit) offset | | tor | ster |
|--------------------|---------------------|---------------------------------|----------|-------------|----------------|
| Indexed (r | Indexed, 1 | Indexed, 2 | Relative | Accumulator | Index register |
| × | ž | IX3 | REL | A | × |
| Bit set/clear | Bit test and branch | Direct | Extended | Inherent | Immediate |
| BSC | BTB | DIR | EXT | HNI | MMI |

7.3 Addressing modes

Ten different addressing modes provide programmers with the flexibility to optimize their code for all situations. The various indexed addressing modes make it possible to locate data tables, code conversion tables and scaling tables anywhere in the memory space. Short indexed accesses are single byte instructions; the longest instructions (three bytes) enable access to tables throughout memory. Short absolute (direct) and long absolute (extended) addressing are also included. One or two byte direct addressing instructions access all data bytes in most applications. Extended addressing permits jump instructions to reach all memory locations.

The term 'effective address' (EA) is used in describing the various addressing modes. The effective address is defined as the address from which the argument for an instruction is fetched or stored. The ten addressing modes of the processor are described below. Parentheses are used to indicate 'contents of' the location or register referred to. For example, (PC) indicates the contents of the location pointed to by the PC (program counter). An arrow indicates 'is replaced by' and a colon indicates concatenation of two bytes. For additional details and graphical illustrations, refer to the *M6805 HMOS/M146805 CMOS Family Microcomputer/Microprocessor User's Manual* or to the *M68HC05 Applications Guide*.

7.3.1 Inherent

0

Freescale Semiconductor,

In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as the control instruction, with no other arguments are included in this mode. These instructions are one byte long.

7.3.2 Immediate

In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants that do not change during program execution (e.g. a constant used to initialize a loop counter).

$$\mathsf{EA} = \mathsf{PC+1}; \mathsf{PC} \leftarrow \mathsf{PC+2}$$

7.3.3 Direct

In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two-byte instruction.

 $\mathsf{EA} = (\mathsf{PC+1}); \mathsf{PC} \leftarrow \mathsf{PC+2}$ Address bus high $\leftarrow 0; \mathsf{Address}$ bus low $\leftarrow (\mathsf{PC+1})$

MC68HC05SU3A

7.3.4 Extended

In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode byte. Instructions with extended addressing mode are capable of referencing arguments anywhere in memory with a single three-byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the short form of the instruction.

$$\label{eq:expectation} \begin{split} \mathsf{EA} &= (\mathsf{PC+1}) (\mathsf{PC+2}); \, \mathsf{PC} \leftarrow \mathsf{PC+3} \\ \mathsf{Address \ bus \ high} \leftarrow (\mathsf{PC+1}); \, \mathsf{Address \ bus \ low} \leftarrow (\mathsf{PC+2}) \end{split}$$

7.3.5 Indexed, no offset

In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. This addressing mode can access the first 256 memory locations. These instructions are only one byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

$$\label{eq:EA} \begin{split} \mathsf{EA} &= \mathsf{X}; \, \mathsf{PC} \leftarrow \mathsf{PC+1} \\ \mathsf{Address \ bus \ high} \leftarrow \mathsf{0}; \, \mathsf{Address \ bus \ low} \leftarrow \mathsf{X} \end{split}$$

7.3.6 Indexed, 8-bit offset

In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. Therefore the operand can be located anywhere within the lowest 511 memory locations. This addressing mode is useful for selecting the mth element in an n element table.

$$\label{eq:expectation} \begin{split} \mathsf{EA} &= \mathsf{X} + (\mathsf{PC} + 1); \, \mathsf{PC} \leftarrow \mathsf{PC} + 2\\ \mathsf{Address \ bus \ high} \leftarrow \mathsf{K}; \, \mathsf{Address \ bus \ low} \leftarrow \mathsf{X} + (\mathsf{PC} + 1)\\ \mathsf{where \ }\mathsf{K} &= \mathsf{the \ carry \ from \ the \ addition \ of \ X \ and \ (\mathsf{PC} + 1)} \end{split}$$

7.3.7 Indexed, 16-bit offset

In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This address mode can be used in a manner similar to indexed, 8-bit offset except that this three-byte instruction allows tables to be anywhere in memory. As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

$$\label{eq:expectation} \begin{split} &\mathsf{EA}=\mathsf{X}+[(\mathsf{PC}+1):(\mathsf{PC}+2)];\,\mathsf{PC}\leftarrow\mathsf{PC}+3\\ &\mathsf{Address\ bus\ high}\leftarrow(\mathsf{PC}+1)+\mathsf{K};\,\mathsf{Address\ bus\ low}\leftarrow\mathsf{X}+(\mathsf{PC}+2)\\ &\text{where\ }\mathsf{K}=\text{the\ carry\ from\ the\ addition\ of\ X\ and\ (\mathsf{PC}+2)} \end{split}$$

7.3.8 Relative

The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte (the offset) following the opcode are added to the PC if, and only if, the branch conditions are true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from -126 to +129 from the opcode address. The programmer need not calculate the offset when using the Motorola assembler, since it calculates the proper offset and checks to see that it is within the span of the branch.

$$\label{eq:expectation} \begin{split} \mathsf{EA} &= \mathsf{PC+2+}(\mathsf{PC+1}); \, \mathsf{PC} \leftarrow \mathsf{EA} \text{ if branch taken}; \\ & \text{otherwise } \mathsf{EA} &= \mathsf{PC} \leftarrow \mathsf{PC+2} \end{split}$$

7.3.9 Bit set/clear

In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode. The byte following the opcode specifies the address of the byte in which the specified bit is to be set or cleared. Any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single two-byte instruction.

$$\label{eq:expectation} \begin{split} \mathsf{EA} &= (\mathsf{PC+1}); \, \mathsf{PC} \leftarrow \mathsf{PC+2} \\ \mathsf{Address \ bus \ high} \leftarrow 0; \, \mathsf{Address \ bus \ low} \leftarrow (\mathsf{PC+1}) \end{split}$$

7.3.10 Bit test and branch

The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit to be tested and its condition (set or clear) is included in the opcode. The address of the byte to be tested is in the single byte immediately following the opcode byte (EA1). The signed relative 8-bit offset in the third byte (EA2) is added to the PC if the specified bit is set or cleared in the specified memory location. This single three-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branch is from -125 to +130 from the opcode address. The state of the tested bit is also transferred to the carry bit of the condition code register.

 $\begin{array}{l} \mathsf{EA1}=(\mathsf{PC+1}); \mathsf{PC} \leftarrow \mathsf{PC+2}\\ \mathsf{Address} \text{ bus high} \leftarrow 0; \mathsf{Address} \text{ bus low} \leftarrow (\mathsf{PC+1})\\ \mathsf{EA2}=\mathsf{PC+3+}(\mathsf{PC+2}); \mathsf{PC} \leftarrow \mathsf{EA2} \text{ if branch taken};\\ \text{ otherwise }\mathsf{PC} \leftarrow \mathsf{PC+3}\\ \end{array}$

THIS PAGE LEFT BLANK INTENTIONALLY

8 LOW POWER MODES

The MC68HC05SU3A has three low-power operating modes. The WAIT and STOP instructions provide two modes that reduce the power required for the MCU by stopping various internal clocks and/or the on-chip oscillator. The flow of the STOP and WAIT modes is shown in Figure 8-1. The third low-power operating mode is the SLOW mode.

8.1 STOP Mode

Execution of the STOP instruction places the MCU in its lowest power consumption mode. In the STOP mode the internal oscillator is turned off, halting all internal processing.

When the CPU enters STOP mode the I-bit in the Condition Code Register is cleared automatically, so that hardware interrupts, IRQ and KBI can "wake" the MCU. All other registers and memory contents remain unaltered. All input/output lines remain unchanged.

The MCU can be brought out of the STOP mode only by a hardware interrupt or an externally generated reset. When exiting the STOP mode the internal oscillator will resume after a pre-defined number of internal processor clock cycles, due to oscillator stabilization.

8.2 WAIT Mode

The WAIT instruction places the MCU in a low-power mode, but consumes more power than the STOP mode. In the WAIT mode the internal processor clock is halted, suspending all processor and internal bus activities. Other Internal clocks remain active, permitting interrupts to be generated from the Timer. The Timer may be used to generate a periodic exit from the WAIT mode or, in conjunction with the external Timer pin, on the occurrence of external events. Execution of the WAIT instruction automatically clears the I-bit in the Condition Code Register, so that any hardware interrupt can "wake" the MCU. All other registers, memory, and input/output lines remain in their previous states.

LOW POWER MODES For More Information On This Product, Go to: www.freescale.com

8

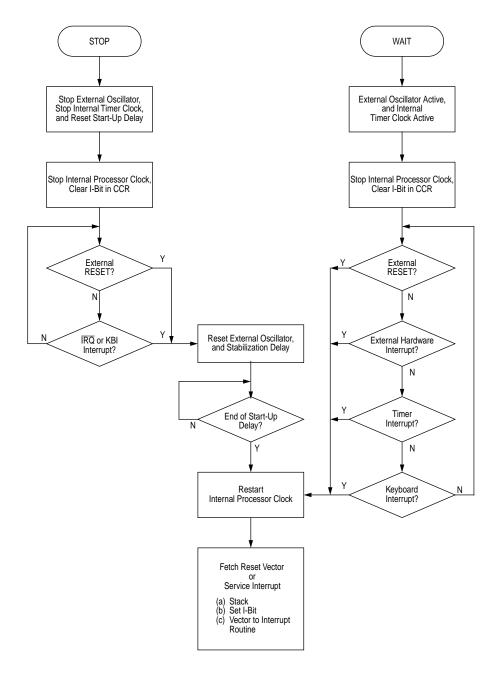


Figure 8-1 STOP and WAIT Mode Flowcharts

8.3 SLOW Mode

The SLOW mode function is controlled by the SM bit in the Miscellaneous Control Register. When the SM bit is set, the internal bus clock is divided by 16, resulting to a frequency equal to the oscillator frequency divide by 32. This feature permits a slow down of all the internal operations and thus reduces power consumption — particularly useful while in WAIT mode. The SM bit is automatically cleared while going to STOP mode.

| | Address | bit 7 | bit 6 | bit 5 | bit 4 | bit 3 | bit 2 | bit 1 | bit 0 | State on reset | |
|--------------------------------|---------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|--|
| Miscellaneous Control Register | \$0C | KBIE | KBIC | INTO | INTE | LVRE | SM | IRQ2F | IRQ2E | 0001 0000 | |

SM — Slow Mode

- 1 (set) Slow mode enabled. Internal bus frequency $f_{OP} = f_{OSC} \div 32$.
- 0 (clear) Slow mode disabled. Internal bus frequency $f_{OP} = f_{OSC} \div 2$.

THIS PAGE LEFT BLANK INTENTIONALLY

9 OPERATING MODES

The MC68HC05SU3A has two modes of operation: the User Mode and the Self-Check Mode. Table 9-1 shows the conditions required for entering the two operating modes.

Table 9-1 Mode Selection

| RESET | V _{PP} | PB1 | MODE |
|------------|----------------------|----------------------|------------|
| 5V | V_{SS} to V_{DD} | V_{SS} to V_{DD} | USER |
| _ _ | V _{TST} | V _{DD} | SELF-CHECK |
| 1/ 01/ | | | |

 $V_{TST} = 2 \times V_{DD}$

9.1 User Mode

The normal operating mode of the MC68HC05SU3A is the User mode. This mode is entered on the rising edge of $\overline{\text{RESET}}$ when the V_PP and PB1 pins are between V_SS and V_DD.

9.2 Self-Check Mode

The Self-check mode is provided on the MC68HC05SU3A for the user to check device functions with an on-chip self-check program masked at location \$1F00 to \$1FEF under minimum hardware support. The self-check schematic is shown in Figure 9-1. Self-check mode is entered on the rising edge of RESET when the V_{PP} pin is at V_{TST} ($2 \times V_{DD}$) and PB1 pin is at V_{DD}. Once in the self-check mode, PB1 can then be used for other purposes. After entering the self-check mode, CPU branches to the self-check program and carries out the self-check. Self-check is a repetitive test, i.e. if all parts are checked to be good, the CPU will repeat the self-check again. Therefore, the LEDs attached to Port A will be flashing if the device is good; else the combination of LEDs' on-off pattern can show what part of the device is suspected to be bad. Table 9-2 lists the LEDs' on-off patterns and their corresponding indications.

OPERATING MODES For More Information On This Product, Go to: www.freescale.com



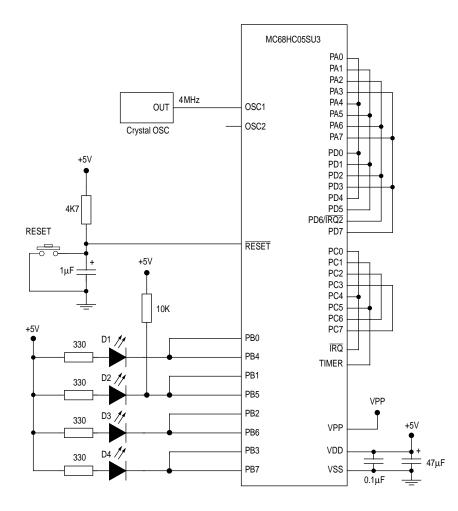


Figure 9-1 MC68HC05SU3A Self-Check Circuit

| D4 | D3 | D2 | D1 | REMARKS | | | | |
|-----------|-----------|------|----|-------------------------------|--|--|--|--|
| | Flas | hing | | O.K. (self-check is on-going) | | | | |
| 1 | 1 | 1 | 1 | Bad port A | | | | |
| 1 | 1 | 1 | 0 | Bad port B | | | | |
| 1 | 1 | 0 | 1 | Bad port C | | | | |
| 1 | 1 | 0 | 0 | Bad port D | | | | |
| 1 | 0 | 1 | 1 | Bad RAM | | | | |
| 1 | 0 | 1 | 0 | Bad ROM | | | | |
| 1 | 0 | 0 | 0 | Bad SWI | | | | |
| 0 | 1 | 1 | 1 | Bad IRQ | | | | |
| 4 1 5 0 - | - 0 I E D | . 11 | | | | | | |

Table 9-2 Self-Check Report

1=LED on, 0=LED off

OPERATING MODES For More Information On This Product, Go to: www.freescale.com



THIS PAGE LEFT BLANK INTENTIONALLY

10 ELECTRICAL SPECIFICATIONS

This section contains the electrical specifications for MC68HC05SU3A.

10.1 Maximum Ratings

(Voltages referenced to Vac)

| RATINGS | SYMBOL | VALUE | UNIT |
|-------------------------------------------------------|------------------|------------------------------------------------------------|------|
| Supply Voltage | V _{DD} | -0.3 to +7.0 | V |
| Input Voltage | V _{IN} | V_{SS} =0.3 to V_{DD} =0.3 | V |
| V _{PP} Pin | V _{IN} | $V_{SS}0.3$ to 2×V_{DD}+0.3 | V |
| Current Drain per pin excluding V_{DD} and V_{SS} | I _D | 25 | mA |
| Operating Temperature Standard Extended | T _A | T _L to T _H 0 to +70 -40 to +85 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | °C |

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this high impedance circuit. For proper operation it is recommended that Vin and Vout be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$. Reliability of operation is enhanced if unused inputs are connected to an appropriate logic voltage level (e.g. either V_{SS} or V_{DD}).

10.2 Thermal Characteristics

| CHARACTERISTICS | SYMBOL | VALUE | UNIT |
|--------------------|-----------------|-------|------|
| Thermal resistance | | | |
| DIP | θ _{JA} | 60 | °C/W |
| SOIC | θ _{JA} | 60 | °C/W |
| QFP | θ _{JA} | 60 | °C/W |

ELECTRICAL SPECIFICATIONS For More Information On This Product, Go to: www.freescale.com

10

10.3 DC Electrical Characteristics

Table 10-1 DC Electrical Characteristics

(V_{DD}=5.0Vdc \pm 10%, V_{SS}=0Vdc, temperature range=0 to 70 °C)

| CHARACTERISTICS | SYMBOL | MINIMUM | TYPICAL | MAXIMUM | UNIT |
|-----------------------------------------------------------------|------------------|----------------------|---------|---------------------|------|
| Output voltage | | | | | |
| $I_{LOAD} = -10\mu A$ | V _{OH} | V _{DD} -0.1 | - | — | V |
| $I_{LOAD} = +10\mu A$ | V _{OL} | - | - | 0.1 | V |
| Output high voltage (I _{LOAD} =-0.8mA): All Ports | V _{OH} | V _{DD} -0.8 | - | - | V |
| Output low voltage (I _{LOAD} =+1.6mA): All Ports | V _{OL} | — | - | 0.4 | V |
| Output high current | | | | | |
| (V _{OH} =2.5V) All ports | l lau | 7 | 10 | 30 | mA |
| (V _{OH} =2.0V) PB5-PB7 in low-current mode (25°C) | IOH | 1.5 | 1.75 | 5 | mA |
| (V _{OH} =2.0V) PB5-PB7 in low-current mode (0 to 70°C) | | 1.25 | 1.75 | 5 | mA |
| Output low current | | | | | |
| (V _{OL} =2.5V) All ports, except PB0 and PB1 | | 7 | 10 | 30 | mA |
| (V _{OL} =3.0V) PB5-PB7 in low-current mode | I _{OL} | 2 | 3.5 | 4.8 | mA |
| (V _{OL} =2.5V) PB0, PB1 | | 40 | 70 | — | mA |
| (V _{OL} =0.4V) PB0, PB1 | | 10 | 20 | — | mA |
| Total I/O port current | 1 | | 100 | | mA |
| Either source or sink | PORT | | 100 | | IIIA |
| Input high voltage | VIH | 0.7×V _{DD} | | V _{DD} | l v |
| PA0-PA7, PB0, PB1, IRQ, RESET, OSC1 | VН | 0.7 ~ VDD | | v DD | v |
| Input low voltage | VIL | V _{SS} | | 0.2×V _{DD} | l v |
| PA0-PA7, PB0, PB1, IRQ, RESET, OSC1 | 1 | *55 | | 0.2 \ \ 00 | · · |
| Supply current: | | | | | |
| Run | | _ | 5.0 | 7.5 | mA |
| Wait | I _{DD} | _ | 1.3 | 2.0 | mA |
| Stop 25°C | | _ | 8 | 20 | μΑ |
| 0°C to +70°C (Standard) | | - | 10 | 30 | μA |
| I/O ports high-Z leakage current | IIL I | _ | | ±10 | μA |
| PA0-PA7, PB2-PB7, PC0-PC7, PD0-PD7 | 11 | | | ± 10 | μη |
| Input current | I _{IN} | _ | | ±2 | μA |
| IRQ, OSC1 | 'IN | | | 12 | μΛ |
| Capacitance | | | | | |
| Ports (as input or output) | C _{OUT} | - | - | 12 | pF |
| RESET, IRQ, OSC1, OSC2 | C _{IN} | _ | - | 8 | pF |
| Low voltage reset threshold | V _{LVR} | 2.8 | 3.5 | 4.2 | V |
| Pull-up resistor | | | | | |
| PA0-PA7, PB2-PB7, PC0-PC7, PD0-PD7 | | 15 | 20 | 90 | KΩ |
| PB0, PB1 | R _{PU} | 1.6 | 1.9 | 2.9 | KΩ |
| RESET | | 20 | 60 | 150 | KΩ |
| IRQ | | 60 | 100 | 300 | KΩ |

Notes: (1) All values shown reflect average measurements.

(2) Typical values at midpoint of voltage range, 25°C only.

(3) Wait I_{DD}: Only timer system active.

(4) Wait, Stop I_{DD}: All ports configured as inputs, V_{IL}=0.2Vdc, V_{IH}=V_{DD}=0.2Vdc.

(5) Run (operating) I_{DD}, Wait I_{DD}: Measured using external square wave clock source to OSC1 (f_{OSC}=2.0MHz), all inputs 0.2Vdc from rail; no DC loads, less than 50pF on all outputs, C₁=20pF on OSC2.

(6) Stop I_{DD} measured with OSC1=V_{SS}.

(7) Wait I_{DD} is affected linearly by the OSC2 capacitance.

10.4 Control Timing

Table 10-2 Control Timing

| CHARACTERISTICS | SYMBOL | MINIMUM | MAXIMUM | UNIT |
|------------------------------------------------------------------|-------------------|--------------|---------|------------------|
| Frequency of operation | | | | |
| RC oscillator Option | f | 0.1 | 4.0 | MHz |
| Crystal option | fosc | 0.1 | 4.0 | MHz |
| External clock option | | dc | 4.0 | MHz |
| Internal operating frequency (f _{OSC} /2) | | | | |
| RC oscillator | f _{OP} | - | 2.0 | MHz |
| Crystal | OP | - | 2.0 | MHz |
| External clock | | dc | 2.0 | MHz |
| Processor cycle time (1/f _{OP}) | t _{CYC} | 500 | — | ns |
| RC oscillator stabilization time | t _{RCON} | — | 1 | ms |
| Crystal oscillator start-up time (crystal oscillator) | t _{OXOV} | — | 100 | ms |
| Stop recovery start-up time (crystal oscillator) | t _{ILCH} | — | 100 | ms |
| RESET pulse width low | t _{RL} | 1.5 | — | t _{CYC} |
| Timer resolution ⁽²⁾ | t _{RESL} | 4.0 | — | t _{CYC} |
| Interrupt pulse width low (edge-triggered) | t _{ILIH} | 125 | — | ns |
| Interrupt pulse period | t _{ILIL} | See note (3) | — | t _{CYC} |
| PA0-PA7 interrupt pulse width high (edge-triggered) | t _{IHIL} | 125 | — | ns |
| PA0-PA7 interrupt pulse period | t _{IHIH} | See note (3) | — | t _{CYC} |
| OSC1 pulse width | t | 90 | — | ns |
| RC oscillator frequency combined stability ⁽⁴⁾ | | | | |
| f_{OSC} =2.0MHz, V_{DD} =5.0Vdc±10%, t_{A} =-40°C to +85°C | Δf_{OSC} | - | ±25 | % |
| f_{OSC} =2.0MHz, V_{DD} =5.0Vdc±10%, t_A =0°C to +40°C | Δf_{OSC} | - | ±15 | % |

Notes:

(1) V_{DD} =5.0Vdc±10%, V_{SS} =0Vdc, t_A = t_L to t_H

(2) The TIMER input pin is the limiting factor in determining timer resolution.

(3) The minimum period t_{ILIL} or t_{IHIH} should not be less than the number of cycles it takes to execute the interrupt service routine plus 19 t_{CYC}.

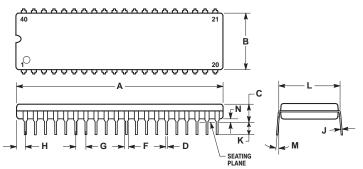
(4) Effects of processing, temperature, and supply voltage (excluding tolerances of external R and C).

THIS PAGE LEFT BLANK INTENTIONALLY

11 MECHANICAL SPECIFICATIONS

This section provides the mechanical dimensions for the 40-pin DIP, 42-pin SDIP and 44-pin QFP packages for the MC68HC05SU3A.







- MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
- 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| | MILLIM | ETERS | INCHES | | |
|-----|-----------|-------|-----------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 51.69 | 52.45 | 2.035 | 2.065 | |
| В | 13.72 | 14.22 | 0.540 | 0.560 | |
| С | 3.94 | 5.08 | 0.155 | 0.200 | |
| D | 0.36 | 0.56 | 0.014 | 0.022 | |
| F | 1.02 | 1.52 | 0.040 | 0.060 | |
| G | 2.54 BSC | | 0.100 BSC | | |
| н | 1.65 | 2.16 | 0.065 | 0.085 | |
| J | 0.20 | 0.38 | 0.008 | 0.015 | |
| K | 2.92 | 3.43 | 0.115 | 0.135 | |
| L | 15.24 BSC | | 0.600 BSC | | |
| M | 0° | 15° | 0° | 15° | |
| N | 0.51 | 1.02 | 0.020 | 0.040 | |

Figure 11-1 40-pin DIP Package

11.2 42-Pin SDIP Package (Case 858-01)

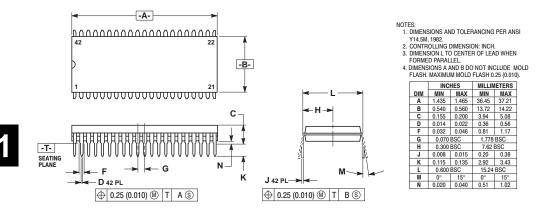


Figure 11-2 42-pin SDIP Package

MECHANICAL SPECIFICATIONS For More Information On This Product, Go to: www.freescale.com

11.3 44-pin QFP Package (Case 824A-01)

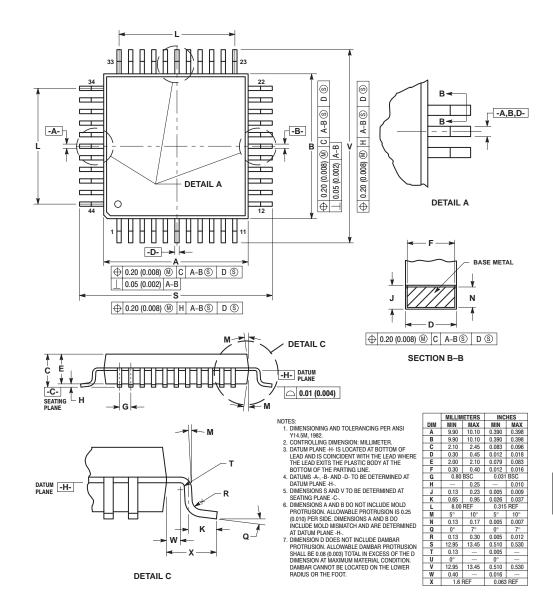


Figure 11-3 44-pin QFP Package

MECHANICAL SPECIFICATIONS For More Information On This Product, Go to: www.freescale.com

THIS PAGE LEFT BLANK INTENTIONALLY

| Freescale Semiconductor, Inc. | | | | | |
|-------------------------------|------------------------------|--|--|--|--|
| 1 | GENERAL DESCRIPTION | | | | |
| 2 | PIN DESCRIPTIONS | | | | |
| 3 | INPUT/OUTPUT PORTS | | | | |
| 4 | MEMORY AND REGISTERS | | | | |
| 5 | RESETS AND INTERRUPTS | | | | |
| 6 | TIMER | | | | |
| 7 | CPU CORE AND INSTRUCTION SET | | | | |
| 8 | LOW POWER MODES | | | | |
| 9 | OPERATING MODES | | | | |
| 10 | ELECTRICAL SPECIFICATIONS | | | | |
| 11 | MECHANICAL SPECIFICATIONS | | | | |

Freescale Semiconductor, Inc. GENERAL DESCRIPTION

PIN DESCRIPTIONS

INPUT/OUTPUT PORTS

MEMORY AND REGISTERS

RESETS AND INTERRUPTS

TIMER

1

CPU CORE AND INSTRUCTION SET

LOW POWER MODES

OPERATING MODES

ELECTRICAL SPECIFICATIONS

MECHANICAL SPECIFICATIONS

For More Information On This Product, Go to: www.freescale.com

For More Information On This Product, Go to: www.freescale.com

Home Page: www.freescale.com email: support@freescale.com USA/Europe or Locations Not Listed: Freescale Semiconductor Technical Information Center, CH370 1300 N. Alma School Road Chandler, Arizona 85224 (800) 521-6274 480-768-2130 support@freescale.com Europe, Middle East, and Africa: Freescale Halbleiter Deutschland GmbH **Technical Information Center** Schatzbogen 7 81829 Muenchen, Germany +44 1296 380 456 (English) +46 8 52200080 (English) +49 89 92103 559 (German) +33 1 69 35 48 48 (French) support@freescale.com Japan: Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku Tokyo 153-0064, Japan 0120 191014 +81 2666 8080 support.japan@freescale.com Asia/Pacific: Freescale Semiconductor Hong Kong Ltd. **Technical Information Center** 2 Dai King Street Tai Po Industrial Estate, Tai Po, N.T., Hong Kong +800 2666 8080 support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center P.O. Box 5405 Denver, Colorado 80217 (800) 441-2447 303-675-2140 Fax: 303-675-2150 LDCForFreescaleSemiconductor @hibbertgroup.com RoHS-compliant and/or Pb- free versions of Freescale products have the functionality and electrical characteristics of their non-RoHS-compliant and/or non-Pb- free counterparts. For further information, see http://www.freescale.com or contact your Freescale sales representative.

For information on Freescale.s Environmental Products program, go to http://www.freescale.com/epp.

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document. Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.



emiconductor,

MC68HC05SU3A/H